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AVAILABLE

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

MAX1126

## General Description

The MAX1126 quad, 12-bit analog-to-digital converter (ADC) features fully differential inputs, a pipelined architecture, and digital error correction. This ADC is optimized for low-power, high-dynamic performance for medical imaging, communications, and instrumentation applications. The MAX1126 operates from a 1.7V to 1.9V single supply and consumes only 563mW while delivering a 69.9dB signal-to-noise ratio (SNR) at a 5.3MHz input frequency. In addition to low operating power, the MAX1126 features an 813μA power-down mode for idle periods.

An internal 1.24V precision bandgap reference sets the ADC's full-scale range. A flexible reference structure allows the use of an external reference for applications requiring increased accuracy or a different input voltage range.

A single-ended clock controls the conversion process. An internal duty-cycle equalizer allows for wide variations in input-clock duty cycle. An on-chip phase-locked loop (PLL) generates the high-speed serial low-voltage differential signaling (LVDS) clock.

The MAX1126 provides serial LVDS outputs for data, clock, and frame alignment signals. The output data is presented in two's complement or binary format.

Refer to the MAX1127 data sheet for a pin-compatible 65Msps version of the MAX1126.

The MAX1126 is available in a small, 10mm x 10mm x 0.9mm, 68-pin QFN package with exposed paddle and is specified for the extended industrial (-40°C to +85°C) temperature range.

## Applications

Ultrasound and Medical Imaging  
Positron Emission Tomography (PET) Imaging  
Multichannel Communication Systems  
Instrumentation

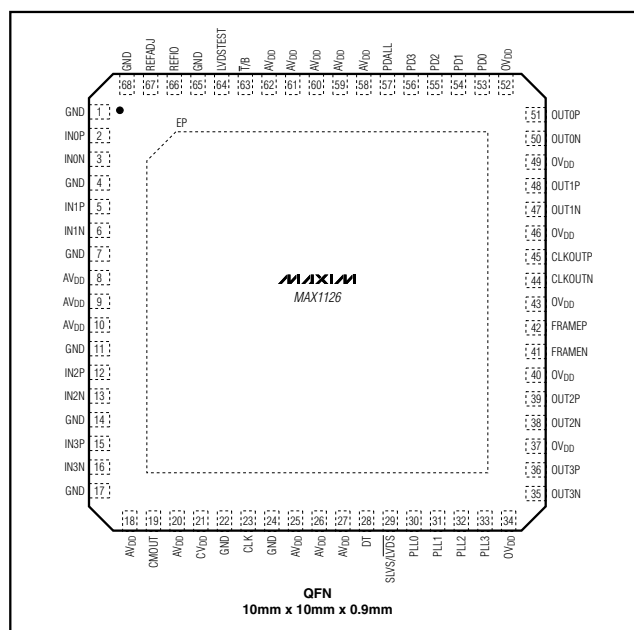
## Features

- ◆ Four ADC Channels with Serial LVDS/SLVS Outputs
- ◆ Excellent Dynamic Performance
  - 69.9dB SNR at  $f_{IN} = 5.3\text{MHz}$
  - 93.7dBc SFDR at  $f_{IN} = 5.3\text{MHz}$
  - 90dB Channel Isolation
- ◆ Ultra-Low Power
  - 135mW per Channel (Normal Operation)
  - 1.5mW Total (Shutdown Mode)
- ◆ Accepts 20% to 80% Clock Duty Cycle
- ◆ Self-Aligning Data-Clock to Data-Output Interface
- ◆ Fully Differential Analog Inputs
- ◆ Wide  $\pm 1.4\text{Vp-p}$  Differential Input Voltage Range
- ◆ Internal/External Reference Option
- ◆ Test Mode for Digital Signal Integrity
- ◆ LVDS Outputs Support Up to 30in FR-4 Backplane Connections
- ◆ Small, 68-Pin QFN with Exposed Paddle
- ◆ Evaluation Kit Available (MAX1127EVKIT)

## Ordering Information

| PART       | TEMP RANGE     | PIN-PACKAGE                     |
|------------|----------------|---------------------------------|
| MAX1126EGK | -40°C to +85°C | 68 QFN 10mm x<br>x 10mm x 0.9mm |

## Pin Configuration



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For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at [www.maxim-ic.com](http://www.maxim-ic.com).

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## ABSOLUTE MAXIMUM RATINGS

AV<sub>DD</sub> to GND ..... -0.3V to +2.0V  
 CV<sub>DD</sub> to GND ..... -0.3V to +3.6V  
 OV<sub>DD</sub> to GND ..... -0.3V to +2.0V  
 IN<sub>P</sub>, IN<sub>N</sub> to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)  
 CLK to GND ..... -0.3V to (CV<sub>DD</sub> + 0.3V)  
 OUT<sub>P</sub>, OUT<sub>N</sub>, FRAME<sub>+</sub>,  
 CLKOUT<sub>+</sub> to GND ..... -0.3V to (OV<sub>DD</sub> + 0.3V)  
 DT, SLVS/LVDS to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)  
 PLL0, PLL1, PLL2, PLL3 to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)  
 PD0, PD1, PD2, PD3, PDALL to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)

T/B, LVDSTEST to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)  
 REFIO, REFADJ, CMOUT, to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)  
 I.C. to GND ..... -0.3V to (AV<sub>DD</sub> + 0.3V)  
 Continuous Power Dissipation (T<sub>A</sub> = +70°C)  
 68-Pin QFN 10mm x 10mm x 0.9mm  
 (derated 41.7mW/°C above +70°C) ..... 3333.3mW  
 Operating Temperature Range ..... -40°C to +85°C  
 Maximum Junction Temperature ..... +150°C  
 Storage Temperature Range ..... -65°C to +150°C  
 Lead Temperature Range (soldering, 10s) ..... +300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

(AV<sub>DD</sub> = 1.8V, OV<sub>DD</sub> = 1.8V, CV<sub>DD</sub> = 1.8V, GND = 0, external V<sub>REFIO</sub> = 1.24V, REFADJ = AV<sub>DD</sub>, C<sub>REFIO</sub> to GND = 0.1μF, f<sub>CLK</sub> = 40MHz (50% duty cycle), DT = 0, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 1)

| PARAMETER                                                            | SYMBOL             | CONDITIONS                                                    | MIN  | TYP   | MAX  | UNITS            |
|----------------------------------------------------------------------|--------------------|---------------------------------------------------------------|------|-------|------|------------------|
| <b>DC ACCURACY</b>                                                   |                    |                                                               |      |       |      |                  |
| Resolution                                                           | N                  |                                                               | 12   |       |      | Bits             |
| Integral Nonlinearity                                                | INL                | (Note 2)                                                      |      | ±0.4  |      | LSB              |
| Differential Nonlinearity                                            | DNL                | (Note 2)                                                      |      | ±0.25 |      | LSB              |
| Offset Error                                                         |                    | Fixed external reference (Note 2)                             |      |       | ±1   | % FS             |
| Gain Error                                                           |                    | Fixed external reference (Note 2)                             | -1.5 | +0.9  | +2.5 | % FS             |
| <b>ANALOG INPUTS (IN<sub>P</sub>, IN<sub>N</sub>)</b>                |                    |                                                               |      |       |      |                  |
| Input Differential Range                                             | V <sub>ID</sub>    | Differential input                                            |      | 1.4   |      | V <sub>P-P</sub> |
| Common-Mode Voltage Range                                            | V <sub>CMO</sub>   | (Note 3)                                                      |      | 0.76  |      | V                |
| Differential Input Impedance                                         | R <sub>IN</sub>    | Switched capacitor load                                       |      | 2     |      | kΩ               |
| Differential Input Capacitance                                       | C <sub>IN</sub>    |                                                               |      | 12.5  |      | pF               |
| <b>CONVERSION RATE</b>                                               |                    |                                                               |      |       |      |                  |
| Maximum Conversion Rate                                              | f <sub>S</sub> MAX |                                                               | 40   |       |      | MHz              |
| Minimum Conversion Rate                                              | f <sub>S</sub> MIN |                                                               |      | 4     |      | MHz              |
| Data Latency                                                         |                    |                                                               |      | 6.5   |      | Cycles           |
| <b>DYNAMIC CHARACTERISTICS (differential inputs, 4096-point FFT)</b> |                    |                                                               |      |       |      |                  |
| Signal-to-Noise Ratio (Note 2)                                       | SNR                | f <sub>IN</sub> = 5.3MHz at -0.5dBFS                          |      | 69.9  |      | dB               |
|                                                                      |                    | f <sub>IN</sub> = 19.3MHz at -0.5dBFS, T <sub>A</sub> ≥ +25°C | 66.7 | 69.2  |      |                  |
| Signal-to-Noise and Distortion (First Four Harmonics) (Note 2)       | SINAD              | f <sub>IN</sub> = 5.3MHz at -0.5dBFS                          |      | 69.8  |      | dB               |
|                                                                      |                    | f <sub>IN</sub> = 19.3MHz at -0.5dBFS, T <sub>A</sub> ≥ +25°C | 66.7 | 69.1  |      |                  |
| Effective Number of Bits (Note 2)                                    | ENOB               | f <sub>IN</sub> = 5.3MHz at -0.5dBFS                          |      | 11.4  |      | Bits             |
|                                                                      |                    | f <sub>IN</sub> = 19.3MHz at -0.5dBFS                         |      | 11.3  |      |                  |

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

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## ELECTRICAL CHARACTERISTICS (continued)

(AVDD = 1.8V, OVDD = 1.8V, CVDD = 1.8V, GND = 0, external VREFIO = 1.24V, REFADJ = AVDD, CREFIO to GND = 0.1μF, fCLK = 40MHz (50% duty cycle), DT = 0, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

| PARAMETER                                                                | SYMBOL | CONDITIONS                                                             | MIN         | TYP        | MAX   | UNITS        |
|--------------------------------------------------------------------------|--------|------------------------------------------------------------------------|-------------|------------|-------|--------------|
| Spurious-Free Dynamic Range (Note 2)                                     | SFDR   | fIN = 5.3MHz at -0.5dBFS                                               |             | 93.7       |       | dBc          |
|                                                                          |        | fIN = 19.3MHz at -0.5dBFS, TA ≥ +25°C                                  | 77.3        | 89         |       |              |
| Total Harmonic Distortion (Note 2)                                       | THD    | fIN = 5.3MHz at -0.5dBFS                                               |             | -91.5      |       | dBc          |
|                                                                          |        | fIN = 19.3MHz at -0.5dBFS, TA ≥ +25°C                                  |             | -88.7      | -76.3 |              |
| Intermodulation Distortion                                               | IMD    | f1 = 12.40125MHz at -6.5dBFS,<br>f2 = 13.60125MHz at -6.5dBFS (Note 2) |             | 87.0       |       | dBc          |
| Third-Order Intermodulation                                              | IM3    | f1 = 12.40125MHz at -6.5dBFS,<br>f2 = 13.60125MHz at -6.5dBFS (Note 2) |             | 89.3       |       | dBc          |
| Aperture Jitter                                                          | tAJ    | (Note 2)                                                               |             | < 0.4      |       | psRMS        |
| Aperture Delay                                                           | tAD    | (Note 2)                                                               |             | 1          |       | ns           |
| Small-Signal Bandwidth                                                   | SSBW   | Input at -20dBFS (Notes 2 and 4)                                       |             | 100        |       | MHz          |
| Full-Power Bandwidth                                                     | LSBW   | Input at -0.5dBFS (Notes 2 and 4)                                      |             | 100        |       | MHz          |
| Output Noise                                                             |        | IN_P = IN_N                                                            |             | 0.45       |       | LSBRMS       |
| Overdrive Recovery Time                                                  | tOR    | RS = 25Ω, CS = 50pF                                                    |             | 1          |       | Clock cycles |
| <b>COMMON-MODE OUTPUT (CMOUT)</b>                                        |        |                                                                        |             |            |       |              |
| CMOUT Output Voltage                                                     | VCMOUT |                                                                        |             | 0.76       |       | V            |
| <b>INTERNAL REFERENCE (REFADJ = GND, bypass REFIO to GND with 0.1μF)</b> |        |                                                                        |             |            |       |              |
| REFADJ Internal Reference Mode Enable Voltage                            |        | (Note 5)                                                               |             | 0.1        |       | V            |
| REFADJ Low-Leakage Current                                               |        |                                                                        |             | 1.6        |       | mA           |
| REFIO Output Voltage                                                     | VREFIO |                                                                        | 1.18        | 1.24       | 1.30  | V            |
| Reference Temperature Coefficient                                        | TREFIO |                                                                        |             | 100        |       | ppm/°C       |
| <b>EXTERNAL REFERENCE (REFADJ = AVDD)</b>                                |        |                                                                        |             |            |       |              |
| REFADJ External Reference Mode Enable Voltage                            |        | (Note 5)                                                               | AVDD - 0.1V |            |       | V            |
| REFADJ High-Leakage Current                                              |        |                                                                        |             | 125        |       | μA           |
| REFIO Input Voltage Range                                                |        |                                                                        |             | 1.24       |       | V            |
| REFIO Input Voltage Tolerance                                            |        |                                                                        |             | ±5         |       | %            |
| REFIO Input Current                                                      | IREFIO |                                                                        |             | < 1        |       | μA           |
| <b>CLOCK INPUT (CLK)</b>                                                 |        |                                                                        |             |            |       |              |
| Input High Voltage                                                       | VCLKH  |                                                                        | 0.8 x AVDD  |            |       | V            |
| Input Low Voltage                                                        | VCLKL  |                                                                        |             | 0.2 x AVDD |       | V            |
| Clock Duty Cycle                                                         |        |                                                                        |             | 50         |       | %            |
| Clock Duty-Cycle Tolerance                                               |        |                                                                        |             | ±30        |       | %            |

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## ELECTRICAL CHARACTERISTICS (continued)

(AVDD = 1.8V, OVDD = 1.8V, CVDD = 1.8V, GND = 0, external VREFIO = 1.24V, REFADJ = AVDD, CREFIO to GND = 0.1μF, fCLK = 40MHz (50% duty cycle), DT = 0, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

| PARAMETER                                                                                   | SYMBOL   | CONDITIONS                | MIN        | TYP        | MAX   | UNITS |
|---------------------------------------------------------------------------------------------|----------|---------------------------|------------|------------|-------|-------|
| Input Leakage                                                                               | DIIN     | Input at GND              |            |            | 5     | μA    |
|                                                                                             |          | Input at AVDD             |            |            | 80    |       |
| Input Capacitance                                                                           | DCIN     |                           |            | 5          |       | pF    |
| <b>DIGITAL INPUTS (PLL_, LVDSTEST, DT, SLVS/LVDS, PD_, PDALL, T/B)</b>                      |          |                           |            |            |       |       |
| Input High Threshold                                                                        | VIH      |                           | 0.8 x AVDD |            |       | V     |
| Input Low Threshold                                                                         | VIL      |                           |            | 0.2 x AVDD |       | V     |
| Input Leakage                                                                               | DIIN     | Input at GND              |            |            | 5     | μA    |
|                                                                                             |          | Input at AVDD             |            |            | 80    |       |
| Input Capacitance                                                                           | DCIN     |                           |            | 5          |       | pF    |
| <b>LVDS OUTPUTS (OUT_P, OUT_N, SLVS/LVDS = 0)</b>                                           |          |                           |            |            |       |       |
| Differential Output Voltage                                                                 | VOHDIFF  | RTERM = 100Ω              | 250        |            | 450   | mV    |
| Output Common-Mode Voltage                                                                  | VOCM     | RTERM = 100Ω              | 1.125      |            | 1.375 | V     |
| Rise Time (20% to 80%)                                                                      | tr       | RTERM = 100Ω, CLOAD = 5pF |            | 150        |       | ps    |
| Fall Time (80% to 20%)                                                                      | tf       | RTERM = 100Ω, CLOAD = 5pF |            | 150        |       | ps    |
| <b>SLVS OUTPUTS (OUT_P, OUT_N, CLKOUTP, CLKOUTN, FRAMEP, FRAMEN), SLVS/LVDS = 1, DT = 1</b> |          |                           |            |            |       |       |
| Differential Output Voltage                                                                 | VOHDIFF  | RTERM = 100Ω              |            | 205        |       | mV    |
| Output Common-Mode Voltage                                                                  | VOCM     | RTERM = 100Ω              |            | 220        |       | mV    |
| Rise Time (20% to 80%)                                                                      | tr       | RTERM = 100Ω, CLOAD = 5pF |            | 120        |       | ps    |
| Fall Time (80% to 20%)                                                                      | tf       | RTERM = 100Ω, CLOAD = 5pF |            | 120        |       | ps    |
| <b>POWER-DOWN</b>                                                                           |          |                           |            |            |       |       |
| PD Fall to Output Enable                                                                    | tENABLE  |                           |            | 132        |       | μs    |
| PD Rise to Output Disable                                                                   | tDISABLE |                           |            | 10         |       | ns    |
| <b>POWER REQUIREMENTS</b>                                                                   |          |                           |            |            |       |       |
| AVDD Supply Voltage                                                                         | AVDD     |                           | 1.7        | 1.8        | 1.9   | V     |
| OVDD Supply Voltage                                                                         | OVDD     |                           | 1.7        | 1.8        | 1.9   | V     |
| CVDD Supply Voltage                                                                         | CVDD     |                           | 1.7        | 1.8        | 3.6   | V     |

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

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## ELECTRICAL CHARACTERISTICS (continued)

(AVDD = 1.8V, OVDD = 1.8V, CVDD = 1.8V, GND = 0, external VREFIO = 1.24V, REFADJ = AVDD, CREFIO to GND = 0.1μF, fCLK = 40MHz (50% duty cycle), DT = 0, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

| PARAMETER                              | SYMBOL | CONDITIONS                                                             | MIN                                                          | TYP               | MAX                 | UNITS |
|----------------------------------------|--------|------------------------------------------------------------------------|--------------------------------------------------------------|-------------------|---------------------|-------|
| AVDD Supply Current                    | IAVDD  | fIN = 19.3MHz at -0.5dBFS                                              | PDALL = 0, all channels active                               | 246               | 285                 | mA    |
|                                        |        |                                                                        | PDALL = 0, all channels active, DT = 1                       | 246               |                     |       |
|                                        |        |                                                                        | PDALL = 0, 1 channel active                                  | 76                |                     |       |
|                                        |        |                                                                        | PDALL = 0, PD[3:0] = 1111                                    | 20                |                     |       |
|                                        |        |                                                                        | PDALL = 1, global power down, PD[3:0] = 1111, no clock input | 438               |                     | μA    |
| OVDD Supply Current                    | IOVDD  | fIN = 19.3MHz at -0.5dBFS                                              | PDALL = 0, all channels active                               | 51                | 57                  | mA    |
|                                        |        |                                                                        | PDALL = 0, all channels active, DT = 1                       | 63                |                     |       |
|                                        |        |                                                                        | PDALL = 0, 1 channel active                                  | 35                |                     |       |
|                                        |        |                                                                        | PDALL = 0, PD[3:0] = 1111                                    | 30                |                     |       |
|                                        |        |                                                                        | PDALL = 1, global power-down, PD[3:0] = 1111, no clock input | 375               |                     | μA    |
| CVDD Supply Current                    | ICVDD  | CVDD is used only to bias ESD-protection diodes on CLK input, Figure 2 |                                                              | 0                 |                     | mA    |
| Power Dissipation                      | PDISS  | fIN = 19.3MHz at -0.5dBFS                                              |                                                              | 535               | 616                 | mW    |
| <b>TIMING CHARACTERISTICS</b> (Note 6) |        |                                                                        |                                                              |                   |                     |       |
| Data Valid to CLKOUT Rise/Fall         | tOD    | fCLK = 40MHz, Figure 5 (Notes 6 and 7)                                 | (tSAMPLE/24) - 0.15                                          | tSAMPLE/24        | (tSAMPLE/24) + 0.15 | ns    |
| CLKOUT Output Width High               | tCH    | Figure 5                                                               |                                                              | tSAMPLE/12        |                     | ns    |
| CLKOUT Output Width Low                | tCL    | Figure 5                                                               |                                                              | tSAMPLE/12        |                     | ns    |
| FRAME Rise to CLKOUT Rise              | tCF    | Figure 4 (Note 7)                                                      | (tSAMPLE/24) - 0.15                                          | tSAMPLE/24        | (tSAMPLE/24) + 0.15 | ns    |
| Sample CLK Rise to Frame Rise          | tsf    | Figure 4 (Notes 7 and 8)                                               | (tSAMPLE/2) + 0.9                                            | (tSAMPLE/2) + 1.3 | (tSAMPLE/2) + 1.7   | ns    |

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## ELECTRICAL CHARACTERISTICS (continued)

(AVDD = 1.8V, OVDD = 1.8V, CVDD = 1.8V, GND = 0, external VREFIO = 1.24V, REFADJ = AVDD, CREFIO to GND = 0.1μF, fCLK = 40MHz (50% duty cycle), DT = 0, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

| PARAMETER                          | SYMBOL | CONDITIONS              | MIN | TYP  | MAX | UNITS   |
|------------------------------------|--------|-------------------------|-----|------|-----|---------|
| <b>CHANNEL-TO-CHANNEL MATCHING</b> |        |                         |     |      |     |         |
| Crosstalk                          |        | (Note 2)                |     | -90  |     | dB      |
| Gain Matching                      |        | fIN = 19.3MHz (Note 2)  |     | ±0.1 |     | dB      |
| Phase Matching                     |        | fIN = 19.3.MHz (Note 2) |     | ±1   |     | Degrees |

**Note 1:** Specifications at TA ≥ +25°C are guaranteed by production testing. Specifications at TA < +25°C are guaranteed by design and characterization and not subject to production testing.

**Note 2:** See definition in the *Parameter Definitions* section.

**Note 3:** The MAX1126 internally sets the common-mode voltage to 0.76V (typ) (see Figure 1). The common-mode voltage can be overdriven to between 0.55V and 0.85V.

**Note 4:** Limited by MAX1127EVKIT input circuitry.

**Note 5:** Connect REFADJ to GND directly to enable internal reference mode. Connect REFADJ to AVDD directly to disable the internal bandgap reference and enable external reference mode.

**Note 6:** Data valid to CLKOUT rise/fall timing is measured from 50% of data output level to 50% of clock output level.

**Note 7:** Guaranteed by design and characterization. Not subject to production testing.

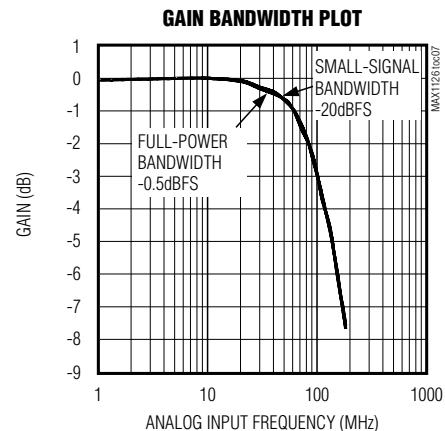
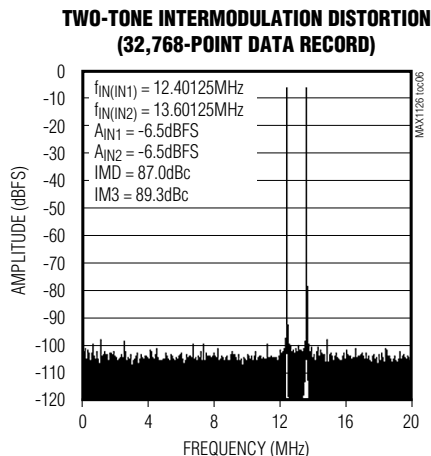
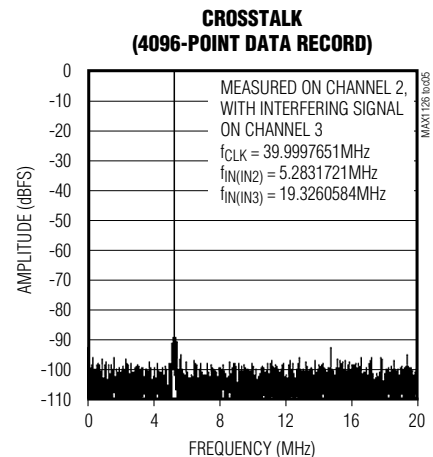
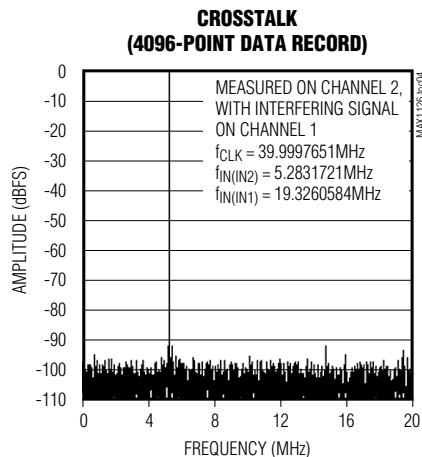
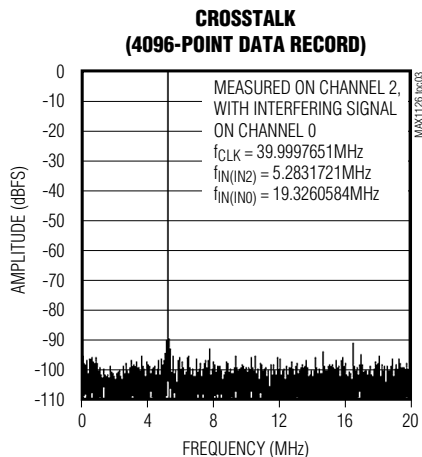
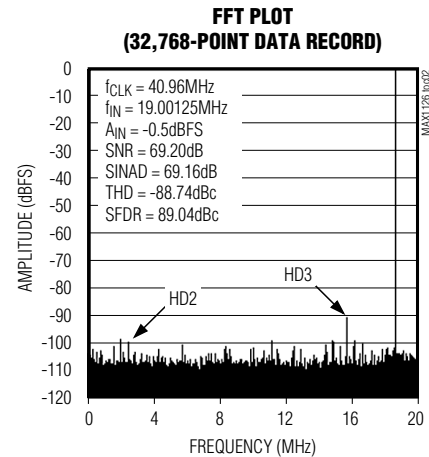
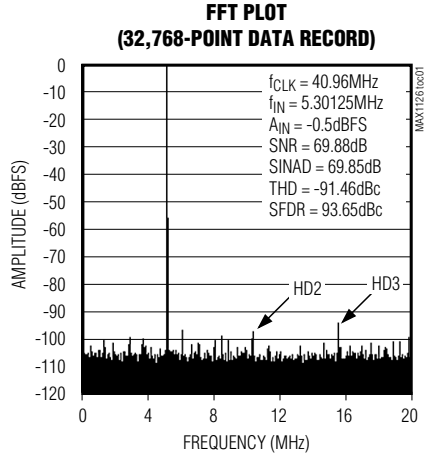
**Note 8:** Sample CLK Rise to FRAME RISE timing is measured from 50% of sample clock input level to 50% of FRAME output level.

# Quad, 12-Bit, 40Mps, 1.8V ADC with Serial LVDS Outputs

## Typical Operating Characteristics

( $AV_{DD} = 1.8V$ ,  $OV_{DD} = 1.8V$ ,  $CV_{DD} = 1.8V$ ,  $GND = 0$ , external  $V_{REFIO} = 1.24V$ ,  $REFADJ = AV_{DD}$ , differential input at  $-0.5dBFS$ ,  $f_{CLK} = 40MHz$  (50% duty cycle),  $DT = low$ ,  $C_{LOAD} = 10pF$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)

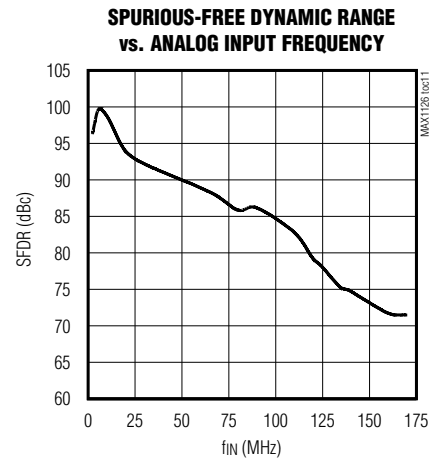
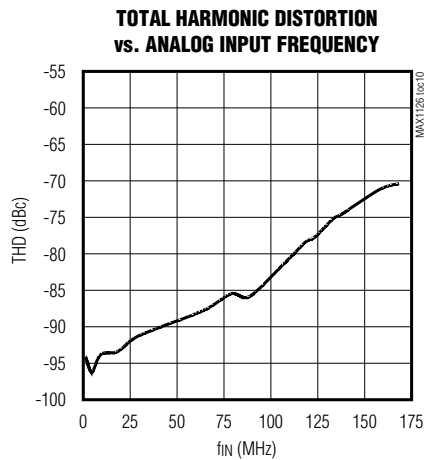
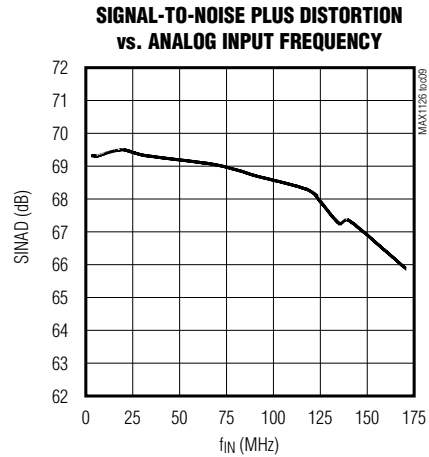
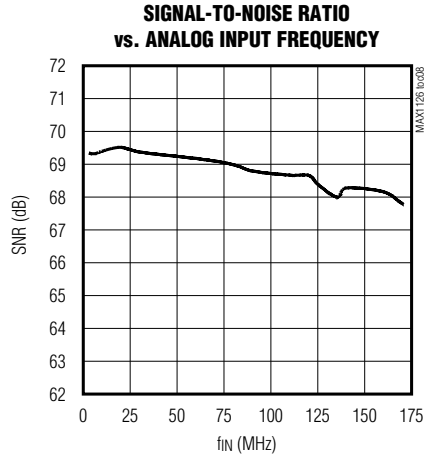
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# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Typical Operating Characteristics (continued)

( $AV_{DD}$  = 1.8V,  $OV_{DD}$  = 1.8V,  $CV_{DD}$  = 1.8V, GND = 0, external  $V_{REFIO}$  = 1.24V,  $REFADJ$  =  $AV_{DD}$ , differential input at -0.5dBFS,  $f_{CLK}$  = 40MHz (50% duty cycle), DT = low,  $C_{LOAD}$  = 10pF,  $T_A$  = +25°C, unless otherwise noted.)

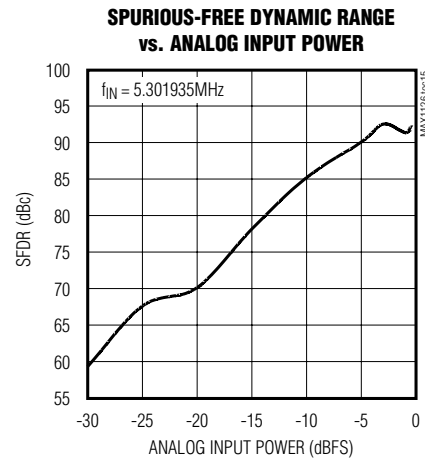
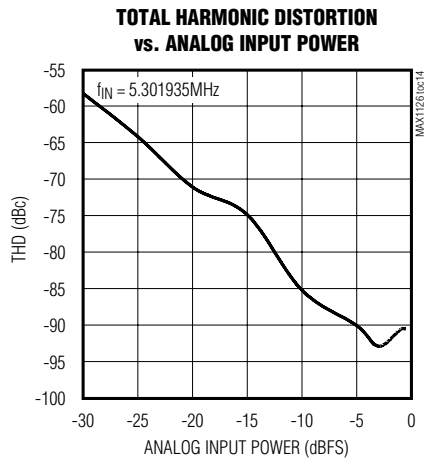
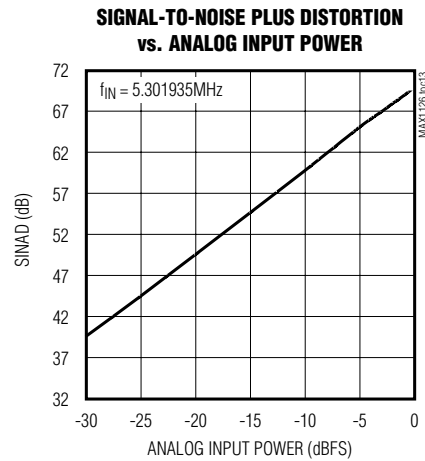
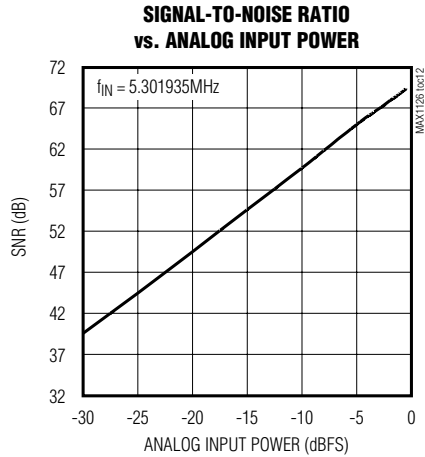


# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

MAX1126

## Typical Operating Characteristics (continued)

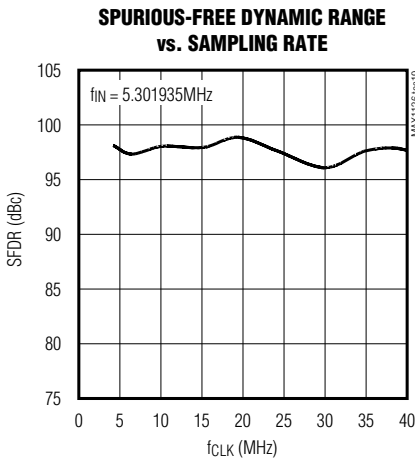
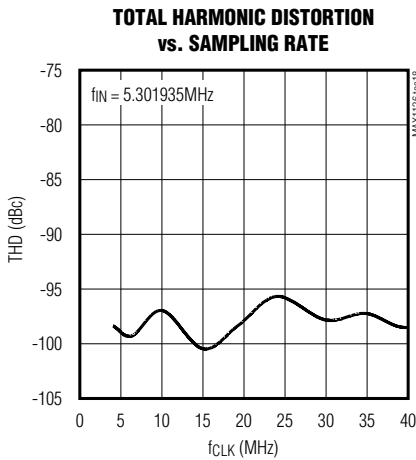
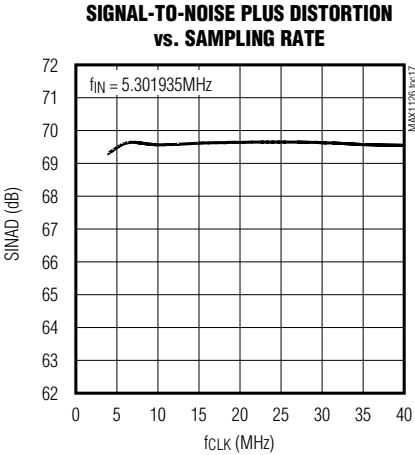
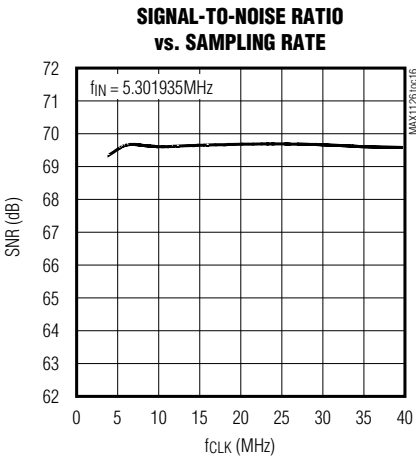
( $A_{VDD} = 1.8V$ ,  $O_{VDD} = 1.8V$ ,  $C_{VDD} = 1.8V$ ,  $GND = 0$ , external  $V_{REFIO} = 1.24V$ ,  $REFADJ = A_{VDD}$ , differential input at  $-0.5dBFS$ ,  $f_{CLK} = 40MHz$  (50% duty cycle),  $DT = low$ ,  $C_{LOAD} = 10pF$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



# **Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs**

## **Typical Operating Characteristics (continued)**

(AVDD = 1.8V, OVDD = 1.8V, CVDD = 1.8V, GND = 0, external VREFIO = 1.24V, REFADJ = AVDD, differential input at -0.5dBFS, fCLK = 40MHz (50% duty cycle), DT = low, CLOAD = 10pF, TA = +25°C, unless otherwise noted.)

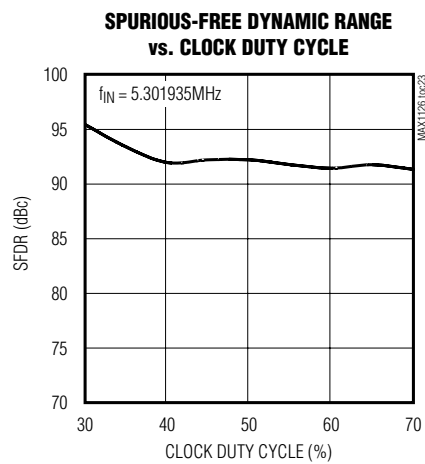
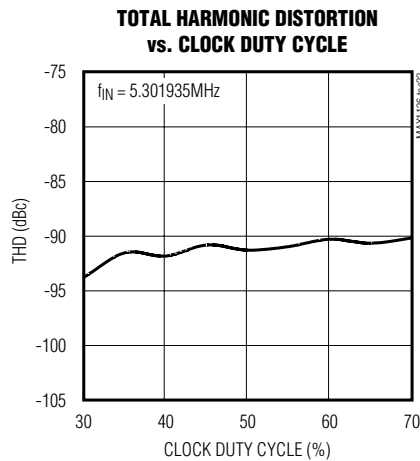
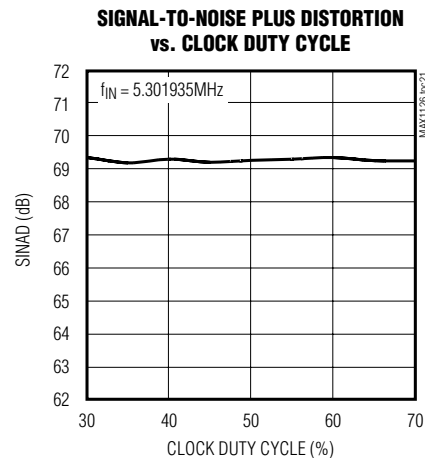
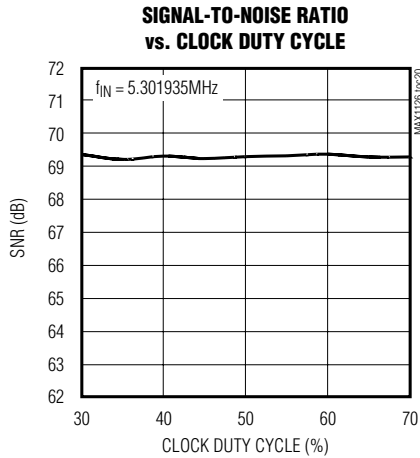


# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

MAX1126

## Typical Operating Characteristics (continued)

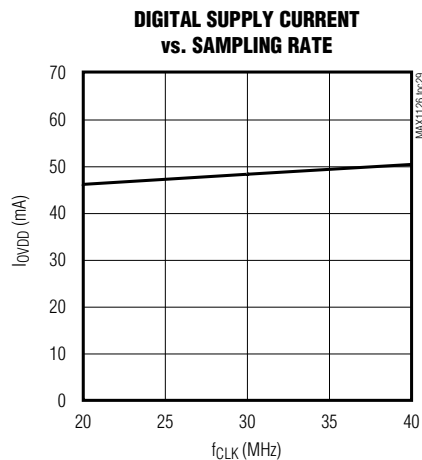
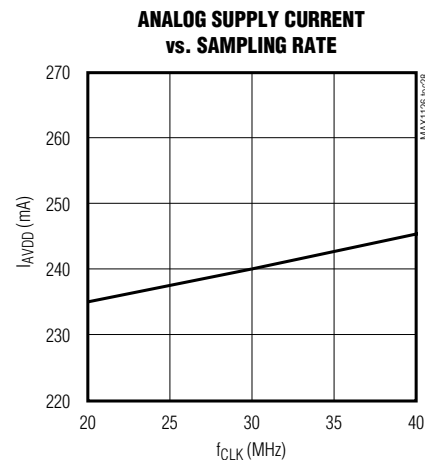
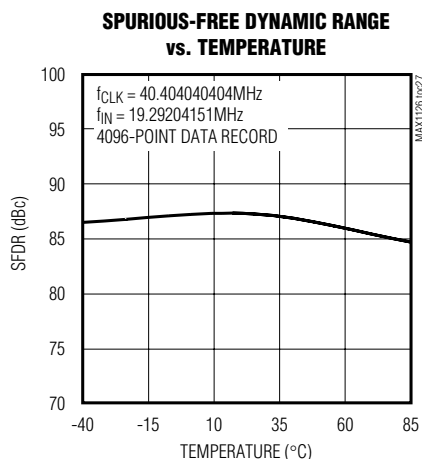
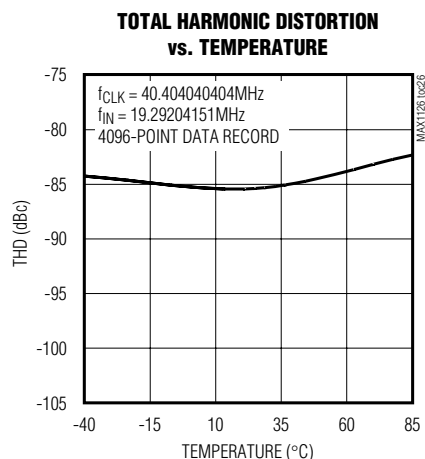
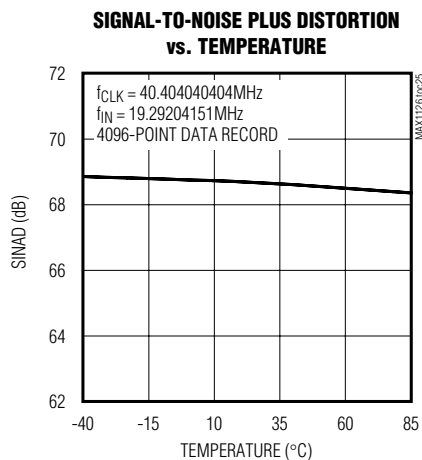
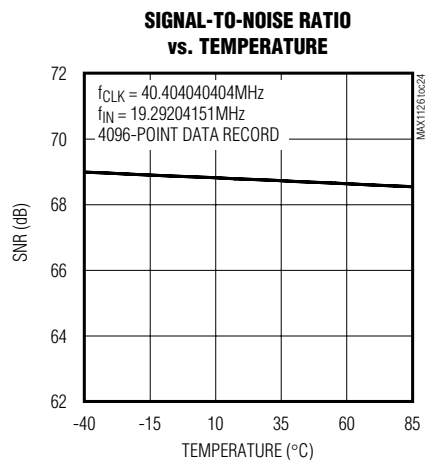
(AVDD = 1.8V, OVDD = 1.8V, CVDD = 1.8V, GND = 0, external VREFIO = 1.24V, REFADJ = AVDD, differential input at -0.5dBFS, fCLK = 40MHz (50% duty cycle), DT = low, CLOAD = 10pF, TA = +25°C, unless otherwise noted.)



# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Typical Operating Characteristics (continued)

( $AV_{DD} = 1.8V$ ,  $OV_{DD} = 1.8V$ ,  $CV_{DD} = 1.8V$ ,  $GND = 0$ , external  $V_{REFIO} = 1.24V$ ,  $REFADJ = AV_{DD}$ , differential input at  $-0.5dBFS$ ,  $f_{CLK} = 40MHz$  (50% duty cycle),  $DT = low$ ,  $C_{LOAD} = 10pF$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



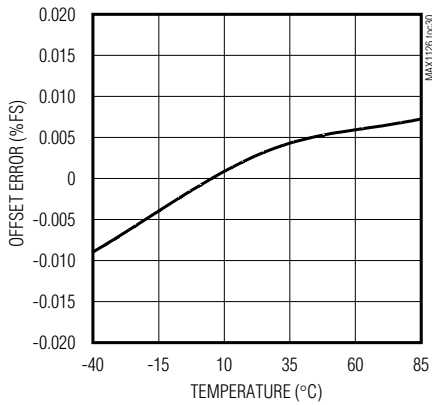
# Quad, 12-Bit, 40Mps, 1.8V ADC with Serial LVDS Outputs

MAX1126

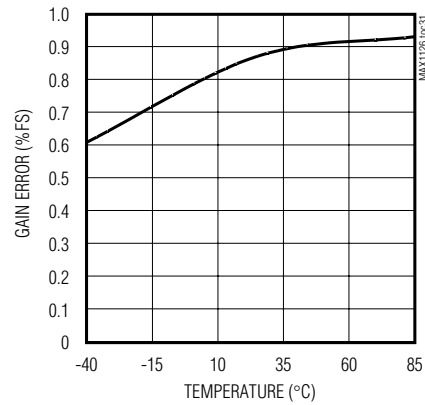
## Typical Operating Characteristics (continued)

( $V_{DD} = 1.8V$ ,  $OV_{DD} = 1.8V$ ,  $CV_{DD} = 1.8V$ ,  $GND = 0$ , external  $V_{REFIO} = 1.24V$ ,  $REFADJ = AV_{DD}$ , differential input at -0.5dBFS,  $f_{CLK} = 40MHz$  (50% duty cycle),  $DT = low$ ,  $C_{LOAD} = 10pF$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)

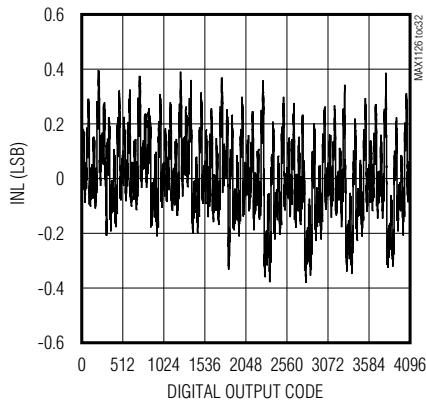
**OFFSET ERROR  
vs. TEMPERATURE**



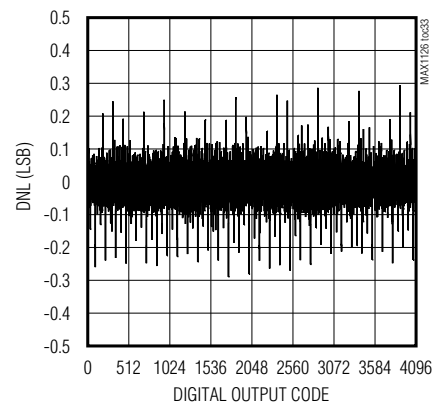
**GAIN ERROR  
vs. TEMPERATURE**



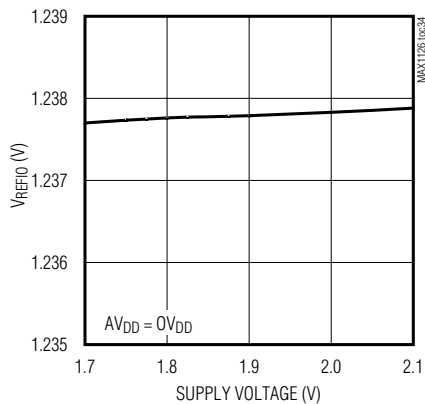
**INTEGRAL NONLINEARITY  
vs. DIGITAL OUTPUT CODE**



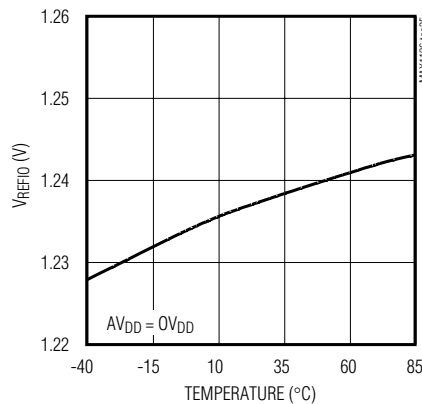
**DIFFERENTIAL NONLINEARITY  
vs. DIGITAL OUTPUT CODE**



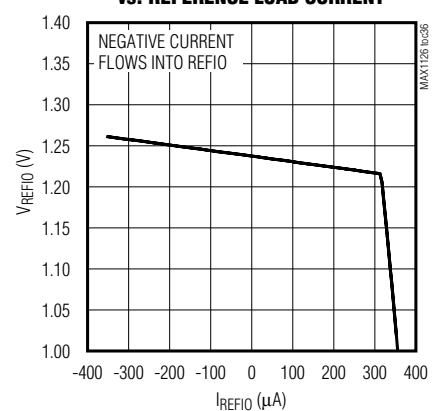
**INTERNAL REFERENCE VOLTAGE  
vs. SUPPLY VOLTAGE**



**INTERNAL REFERENCE VOLTAGE  
vs. TEMPERATURE**



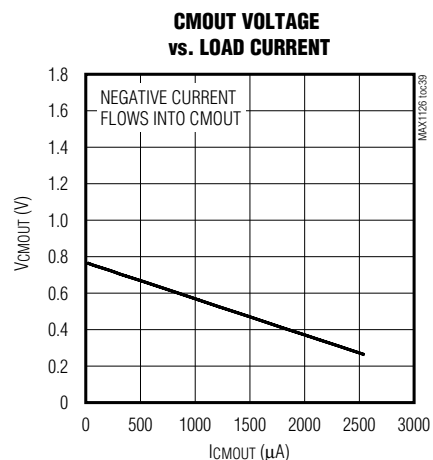
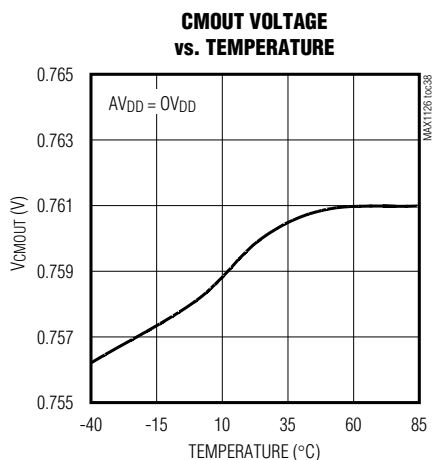
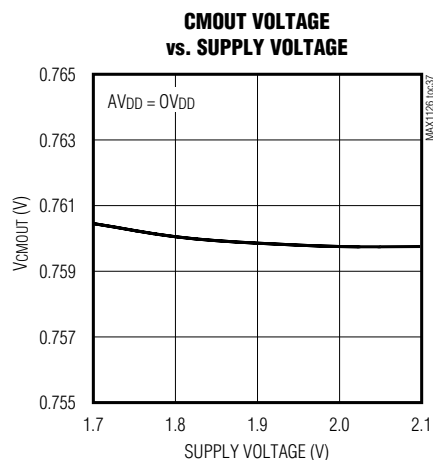
**INTERNAL REFERENCE VOLTAGE  
vs. REFERENCE LOAD CURRENT**



# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Typical Operating Characteristics (continued)

(AV<sub>DD</sub> = 1.8V, OV<sub>DD</sub> = 1.8V, CV<sub>DD</sub> = 1.8V, GND = 0, external V<sub>REFIO</sub> = 1.24V, REFADJ = AV<sub>DD</sub>, differential input at -0.5dBFS, f<sub>CLK</sub> = 40MHz (50% duty cycle), DT = low, C<sub>LOAD</sub> = 10pF, T<sub>A</sub> = +25°C, unless otherwise noted.)



## Pin Description

| PIN                                 | NAME             | FUNCTION                                                                                                                                                                                                                                                                                                                                                               |
|-------------------------------------|------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1, 4, 7, 11, 14, 17, 22, 24, 65, 68 | GND              | Ground. Connect all GND pins to the same potential.                                                                                                                                                                                                                                                                                                                    |
| 2                                   | IN0P             | Channel 0 Positive Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 3                                   | IN0N             | Channel 0 Negative Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 5                                   | IN1P             | Channel 1 Positive Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 6                                   | IN1N             | Channel 1 Negative Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 8, 9, 10, 18, 20, 25, 26, 27, 58–62 | AV <sub>DD</sub> | Analog Power Input. Connect AV <sub>DD</sub> to a 1.7V to 1.9V power supply. Bypass each AV <sub>DD</sub> to GND with a 0.1μF capacitor as close to the device as possible. Bypass the AV <sub>DD</sub> power plane to the GND ground plane with a bulk ≥ 2.2μF capacitor as close to the device as possible. Connect all AV <sub>DD</sub> pins to the same potential. |
| 12                                  | IN2P             | Channel 2 Positive Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 13                                  | IN2N             | Channel 2 Negative Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 15                                  | IN3P             | Channel 3 Positive Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 16                                  | IN3N             | Channel 3 Negative Analog Input                                                                                                                                                                                                                                                                                                                                        |
| 19                                  | CMOUT            | Common-Mode Reference Voltage Output. Bypass CMOUT to GND with a 0.1μF capacitor.                                                                                                                                                                                                                                                                                      |
| 21                                  | CV <sub>DD</sub> | Clock Power Input. Connect CV <sub>DD</sub> to a 1.7V to 3.6V supply. Bypass CV <sub>DD</sub> to GND with a 0.1μF capacitor in parallel with a ≥ 2.2μF capacitor. Install the bypass capacitors as close to the device as possible.                                                                                                                                    |
| 23                                  | CLK              | Single-Ended CMOS Clock Input                                                                                                                                                                                                                                                                                                                                          |
| 28                                  | DT               | Double Termination Select Input. Drive DT high to select the internal 100Ω termination between the differential output pairs. Drive DT low to select no internal output termination.                                                                                                                                                                                   |

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Pin Description (continued)

MAX1126

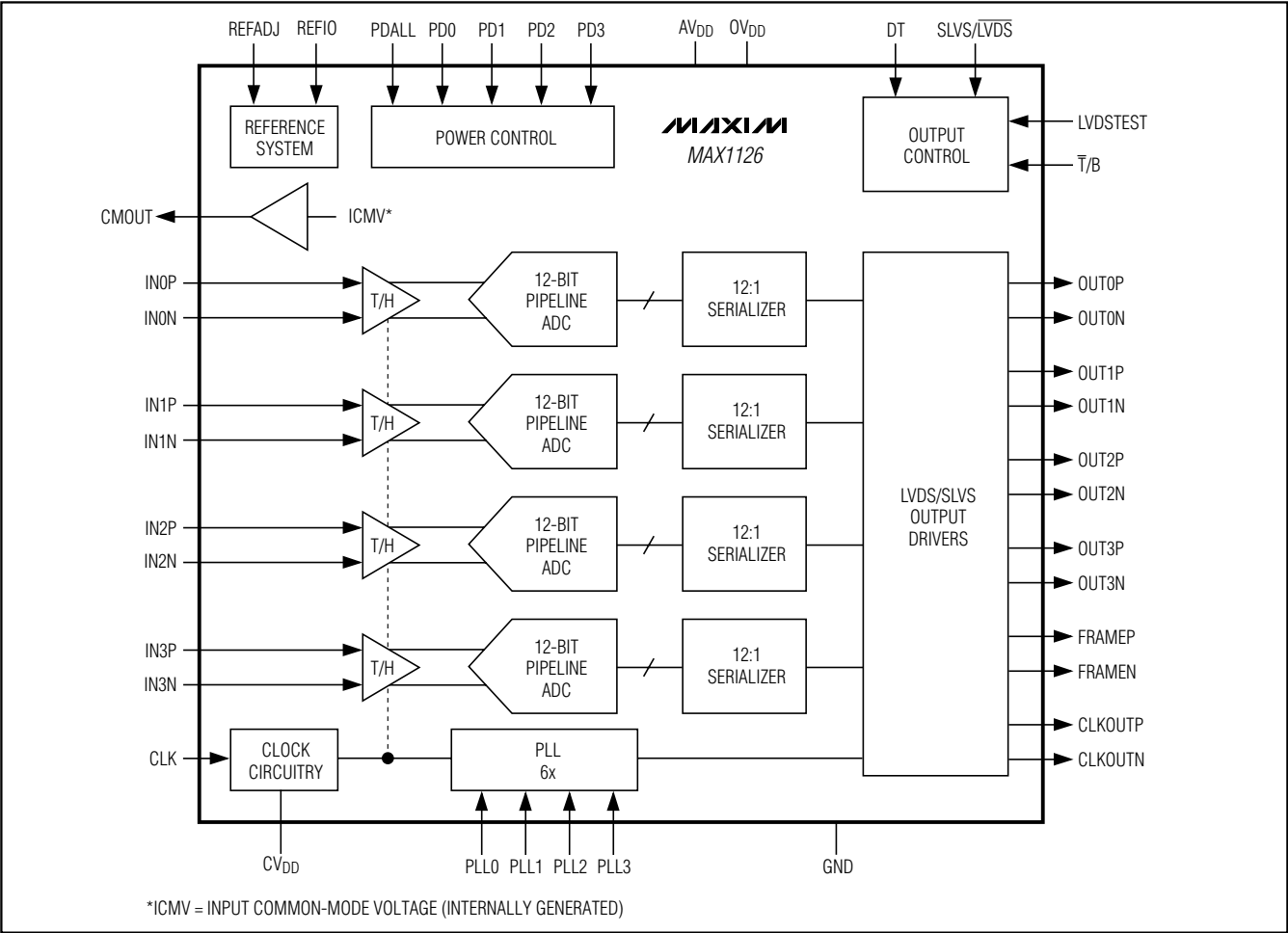
| PIN                        | NAME      | FUNCTION                                                                                                                                                                                                                                                                                                                     |
|----------------------------|-----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 29                         | SLVS/LVDS | Differential Output Signal Format Select Input. Drive SLVS/LVDS high to select SLVS outputs. Drive SLVS/LVDS low to select LVDS outputs.                                                                                                                                                                                     |
| 30                         | PLL0      | PLL Control Input 0. PLL0 is reserved for factory testing only and must always be connected to GND.                                                                                                                                                                                                                          |
| 31                         | PLL1      | PLL Control Input 1. See Table 1 for details.                                                                                                                                                                                                                                                                                |
| 32                         | PLL2      | PLL Control Input 2. See Table 1 for details.                                                                                                                                                                                                                                                                                |
| 33                         | PLL3      | PLL Control Input 3. See Table 1 for details.                                                                                                                                                                                                                                                                                |
| 34, 37, 40, 43, 46, 49, 52 | OVDD      | Output-Driver Power Input. Connect OVDD to a 1.7V to 1.9V power supply. Bypass each OVDD to GND with a 0.1μF capacitor as close to the device as possible. Bypass the OVDD power plane to the GND ground plane with a bulk ≥2.2μF capacitor as close to the device as possible. Connect all OVDD pins to the same potential. |
| 35                         | OUT3N     | Channel 3 Negative LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 36                         | OUT3P     | Channel 3 Positive LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 38                         | OUT2N     | Channel 2 Negative LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 39                         | OUT2P     | Channel 2 Positive LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 41                         | FRAMEN    | Negative Frame Alignment LVDS/SLVS Output. A rising edge on the differential FRAME output aligns to a valid D0 in the output data stream.                                                                                                                                                                                    |
| 42                         | FRAMEP    | Positive Frame Alignment LVDS/SLVS Output. A rising edge on the differential FRAME output aligns to a valid D0 in the output data stream.                                                                                                                                                                                    |
| 44                         | CLKOUTN   | Negative LVDS/SLVS Serial Clock Output                                                                                                                                                                                                                                                                                       |
| 45                         | CLKOUTP   | Positive LVDS/SLVS Serial Clock Output                                                                                                                                                                                                                                                                                       |
| 47                         | OUT1N     | Channel 1 Negative LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 48                         | OUT1P     | Channel 1 Positive LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 50                         | OUT0N     | Channel 0 Negative LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 51                         | OUT0P     | Channel 0 Positive LVDS/SLVS Output                                                                                                                                                                                                                                                                                          |
| 53                         | PD0       | Channel 0 Power-Down Input. Drive PD0 high to power-down channel 0. Drive PD0 low for normal operation.                                                                                                                                                                                                                      |
| 54                         | PD1       | Channel 1 Power-Down Input. Drive PD1 high to power-down channel 1. Drive PD1 low for normal operation.                                                                                                                                                                                                                      |
| 55                         | PD2       | Channel 2 Power-Down Input. Drive PD2 high to power-down channel 2. Drive PD2 low for normal operation.                                                                                                                                                                                                                      |
| 56                         | PD3       | Channel 3 Power-Down Input. Drive PD3 high to power-down channel 3. Drive PD3 low for normal operation.                                                                                                                                                                                                                      |
| 57                         | PDALL     | Global Power-Down Input. Drive PDALL high to power-down all channels and reference. Drive PDALL low for normal operation.                                                                                                                                                                                                    |
| 63                         | T̄/B      | Output Format Select Input. Drive T̄/B high to select binary output format. Drive T̄/B low to select two's complement output format.                                                                                                                                                                                         |

# **Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs**

## **Pin Description (continued)**

| PIN | NAME     | FUNCTION                                                                                                                                                                                                                                                                               |
|-----|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 64  | LVDSTEST | LVDS Test Pattern Enable Input. Drive LVDSTEST high to enable the output test pattern (000010111101 MSB→LSB). As with the analog conversion results, the test pattern data is output LSB first. Drive LVDSTEST low for normal operation.                                               |
| 66  | REFIO    | Reference Input/Output. For internal reference operation (REFADJ = GND), the reference output voltage is 1.24V. For external reference operation (REFADJ = AVDD), apply a stable reference voltage at REFIO. Bypass to GND with a 0.1μF capacitor.                                     |
| 67  | REFADJ   | Internal/External Reference Mode Select Input. For internal reference mode, connect REFADJ directly to GND. For external reference mode, connect REFADJ directly to AVDD. For reference-adjust mode, see the <i>Full-Scale Range Adjustments Using the Internal Reference</i> section. |
| —   | EP       | Exposed Paddle. EP is internally connected to GND. Externally connect EP to GND to achieve specified performance.                                                                                                                                                                      |

## **Functional Diagram**



# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Detailed Description

The MAX1126 ADC features fully differential inputs, a pipelined architecture, and digital error correction for high-speed signal conversion. The ADC pipeline architecture moves the samples taken at the inputs through the pipeline stages every half clock cycle. The converted digital results are serialized and sent through the LVDS/SLVS output drivers. The total latency from input to output is 6.5 input clock cycles.

The MAX1126 offers four separate fully differential channels with synchronized inputs and outputs. Configure the outputs for binary or two's complement with the  $\overline{T}/B$  digital input. Power-down each channel individually or globally to minimize power consumption.

## Input Circuit

Figure 1 displays a simplified functional diagram of the input T/H circuits. In track mode, switches S1, S2a, S2b, S4a, S4b, S5a, and S5b are closed. The fully differential circuits sample the input signals onto the two capacitors (C2a and C2b) through switches S4a and S4b. S2a and S2b set the common mode for the operational transcon-

ductance amplifier (OTA), and open simultaneously with S1, sampling the input waveform. Switches S4a, S4b, S5a, and S5b are then opened before switches S3a and S3b connect capacitors C1a and C1b to the output of the amplifier and switch S4c is closed. The resulting differential voltages are held on capacitors C2a and C2b. The amplifiers charge capacitors C1a and C1b to the same values originally held on C2a and C2b. These values are then presented to the first-stage quantizers and isolate the pipelines from the fast-changing inputs. Analog inputs IN\_P to IN\_N are driven differentially. For differential inputs, balance the input impedance of IN\_P and IN\_N for optimum performance.

The MAX1126 analog inputs are self-biased at a common-mode voltage of 0.76V (typ) and allow a differential input voltage swing of 1.4Vp-p. The common-mode voltage can be overdriven to between 0.55V and 0.85V. Drive the analog inputs of the MAX1126 in AC-coupled configuration to achieve best dynamic performance. See the *Using Transformer Coupling* section for a detailed discussion of this configuration.

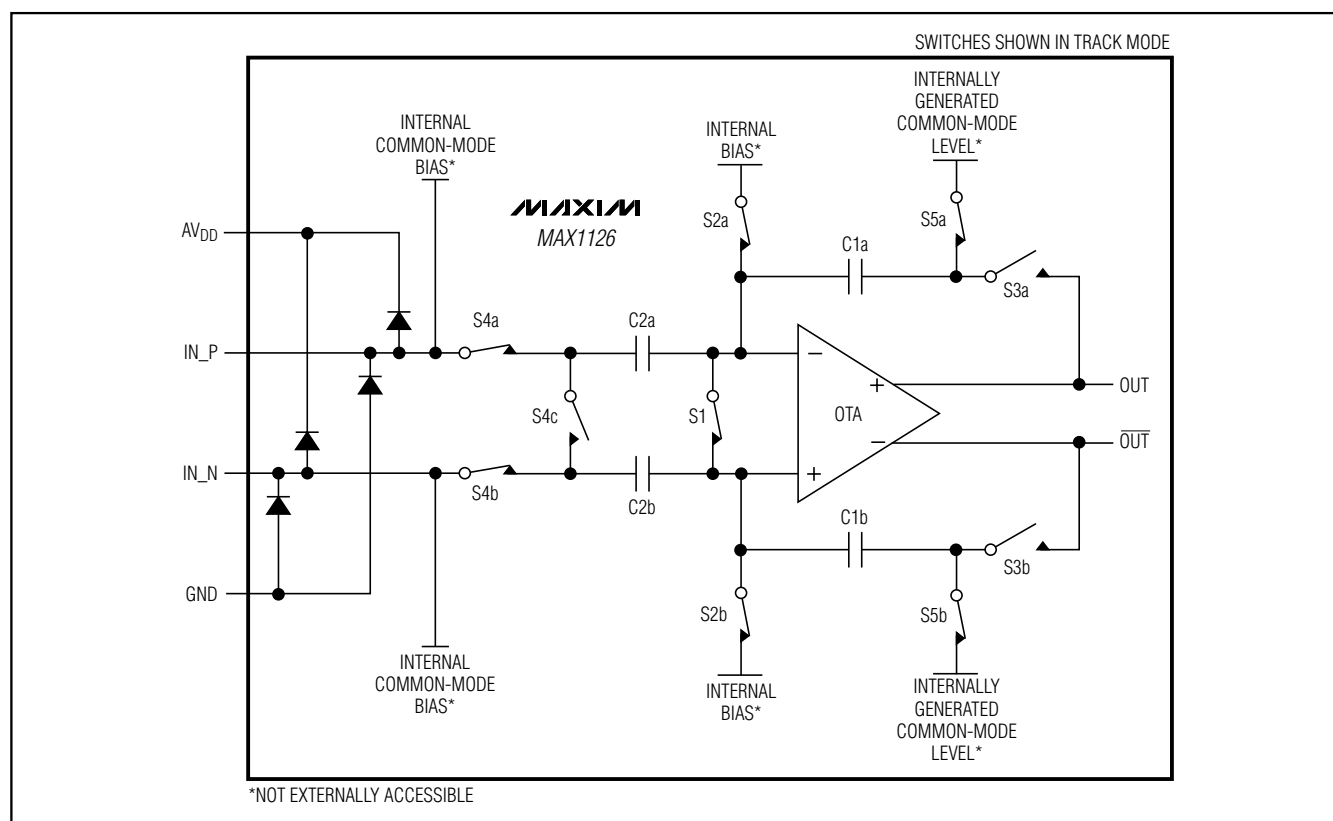


Figure 1. Internal Input Circuitry

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Reference Configurations (REFIO and REFADJ)

The MAX1126 provides an internal 1.24V bandgap reference or can be driven with an external reference voltage. The MAX1126 full-scale analog differential input range is  $\pm\text{FSR}$ . Full-scale range (FSR) is given by the following equation:

$$\text{FSR} = 700\text{mV} \times \frac{V_{\text{REFIO}}}{1.24\text{V}}$$

where  $V_{\text{REFIO}}$  is the voltage at REFIO, generated internally or externally. For a  $V_{\text{REFIO}} = 1.24\text{V}$ , the full-scale input range is  $\pm 700\text{mV}$  ( $1.4\text{V}_{\text{P-P}}$ ).

## Internal Reference Mode

Connect REFADJ to GND to use the internal bandgap reference directly. The internal bandgap reference generates REFIO to be 1.24V with a 100ppm/°C temperature coefficient in internal reference mode. Connect an external  $\geq 0.1\mu\text{F}$  bypass capacitor from REFIO to GND for stability. REFIO sources up to 200 $\mu\text{A}$  and sinks up to 200 $\mu\text{A}$  for external circuits, and REFIO has a load regulation of 83mV/mA. The global power-down input (PDALL) enables and disables the reference circuit. REFIO has  $> 1\text{M}\Omega$  resistance to GND when the MAX1126 is in power-down mode. The internal reference circuit requires 132 $\mu\text{s}$  to power-up and settle when power is applied to the MAX1126 or when PDALL transitions from high to low.

To compensate for gain errors or to decrease or increase the ADC's full-scale range (FSR), add an external resistor between REFADJ and GND or REFADJ and REFIO. This adjusts the internal reference value of the MAX1126 by up to  $\pm 5\%$  of its nominal value. See the *Full-Scale Range Adjustments Using the Internal Reference* section.

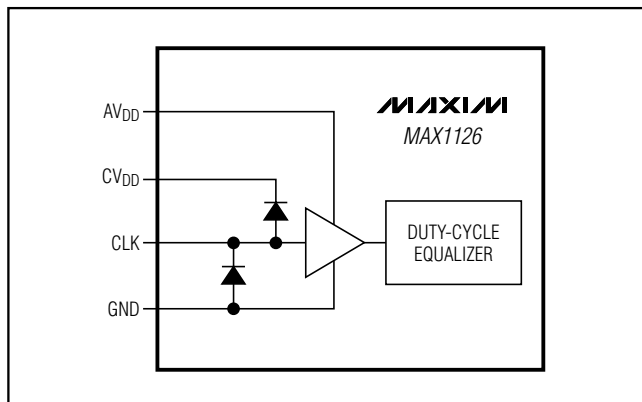


Figure 2. Clock Input Circuitry

## External Reference Mode

The external reference mode allows for more control over the MAX1126 reference voltage and allows multiple converters to use a common reference. Connect REFADJ to AVDD to disable the internal reference and enter external reference mode. Apply a stable 1.18V to 1.30V source at REFIO. Bypass REFIO to GND with a 0.1 $\mu\text{F}$  capacitor. The REFIO input impedance is  $> 1\text{M}\Omega$ .

## Clock Input (CLK)

The MAX1126 accepts a CMOS-compatible clock signal with a wide 20% to 80% input-clock duty cycle. Drive CLK with an external single-ended clock signal. Figure 2 shows the simplified clock input diagram.

Low clock jitter is required for the specified SNR performance of the MAX1126. Analog input sampling occurs on the rising edge of CLK, requiring this edge to provide the lowest possible jitter. Jitter limits the maximum SNR performance of any ADC according to the following relationship:

$$\text{SNR} = 20 \times \log \left( \frac{1}{2 \times \pi \times f_{\text{IN}} \times t_{\text{J}}} \right)$$

where  $f_{\text{IN}}$  represents the analog input frequency and  $t_{\text{J}}$  is the total system clock jitter. Clock jitter is especially critical for undersampling applications. For example, assuming that clock jitter is the only noise source, to obtain the specified 69.2dB of SNR with an input frequency of 19.3MHz, the system must have less than 2.8psRMS of clock jitter. In actuality, there are other noise sources, such as thermal noise and quantization noise, that contribute to the system noise requiring the clock jitter to be less than 1.1psRMS to obtain the specified 69.2dB of SNR at 19.3MHz.

Table 1. PLL1, PLL2, and PLL3 Configuration

| PLL1 | PLL2 | PLL3 | CLOCK INPUT RANGE (MHz) |      |
|------|------|------|-------------------------|------|
|      |      |      | MIN                     | MAX  |
| 0    | 0    | 0    | NOT USED                |      |
| 0    | 0    | 1    | 32.5                    | 40.0 |
| 0    | 1    | 0    | 22.5                    | 32.5 |
| 0    | 1    | 1    | 16.3                    | 22.5 |
| 1    | 0    | 0    | 11.3                    | 16.3 |
| 1    | 0    | 1    | 8.1                     | 11.3 |
| 1    | 1    | 0    | 5.6                     | 8.1  |
| 1    | 1    | 1    | 4.0                     | 5.6  |

\*PLL0 is reserved for factory testing and must always be connected to GND.

## Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

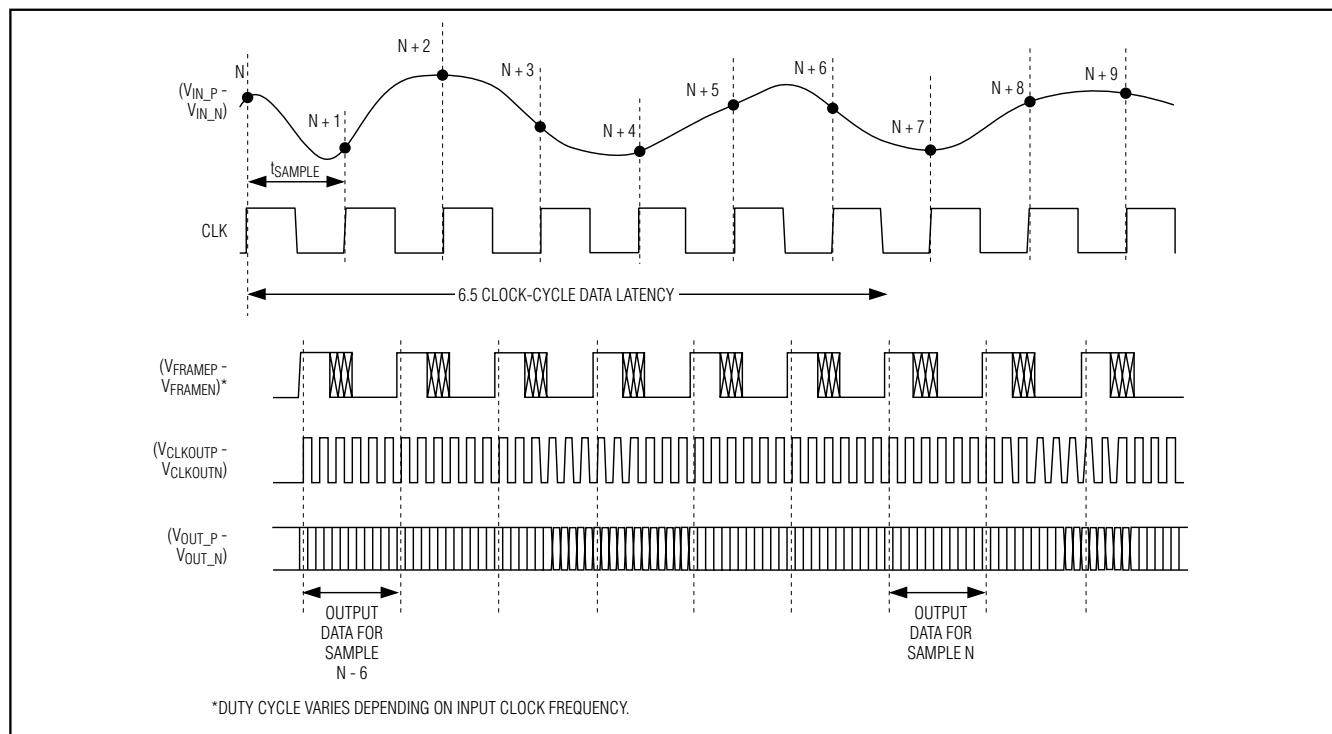


Figure 3. Global Timing Diagram

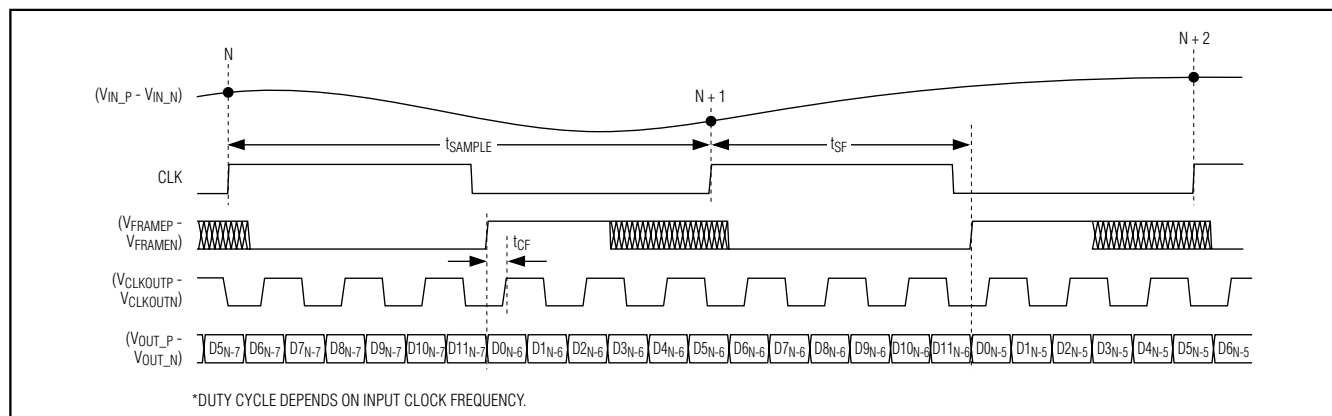


Figure 4. Detailed Two-Conversion Timing Diagram

### PLL Inputs (PLL0–PLL3)

The MAX1126 features a PLL that generates an output clock signal with 6 times the frequency of the input clock. The output clock signal is used to clock data out of the MAX1126 (see the *System Timing Requirements* section). Set the PLL1, PLL2, and PLL3 bits according to the input clock range provided in Table 1. PLL0 is reserved for factory testing and must always be connected to GND.

### System Timing Requirements

Figure 3 shows the relationship between the analog inputs, input clock, frame alignment output, serial clock output, and serial data output. The differential analog input (IN\_P and IN\_N) is sampled on the rising edge of the CLK signal and the resulting data appears at the digital outputs 6.5 clock cycles later. Figure 4 provides a detailed, two-conversion timing diagram of the relationship between the inputs and the outputs.

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Clock Output (CLKOUTP, CLKOUTN)

The MAX1126 provides a differential clock output that consists of CLKOUTP and CLKOUTN. As shown in Figure 4, the serial output data is clocked out of the MAX1126 on both edges of the clock output. The frequency of the output clock is 6 times the frequency of CLK.

## Frame Alignment Output (FRAMEP, FRAMEN)

The MAX1126 provides a differential frame alignment signal that consists of FRAMEP and FRAMEN. As shown in Figure 4, the rising edge of the frame alignment signal corresponds to the first bit (D0) of the 12-bit serial data stream. The frequency of the frame alignment signal is identical to the frequency of the sample clock.

## Serial Output Data (OUT\_P, OUT\_N)

The MAX1126 provides its conversion results through individual differential outputs consisting of OUT\_P and OUT\_N. The results are valid 6.5 input clock cycles after the sample is taken. As shown in Figure 3, the output data is clocked out on both edges of the output clock, LSB (D0) first. Figure 5 provides the detailed serial output timing diagram.

## Output Data Format ( $\overline{T}/B$ ), Transfer Functions

The MAX1126 output data format is either offset binary or two's complement, depending on the logic input  $\overline{T}/B$ . With  $\overline{T}/B$  low, the output data format is two's complement. With  $\overline{T}/B$  high, the output data format is offset binary. The following equations, Table 2, Figure 6, and Figure 7 define the relationship between the digital

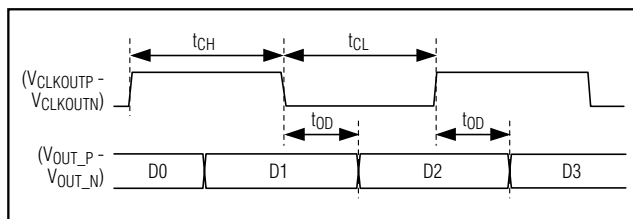


Figure 5. Serialized Output Detailed Timing Diagram

output and the analog input. For two's complement ( $\overline{T}/B = 0$ ):

$$V_{IN\_P} - V_{IN\_N} = FSR \times 2 \times \frac{CODE_{10}}{4096}$$

and for offset binary ( $\overline{T}/B = 1$ ):

$$V_{IN\_P} - V_{IN\_N} = FSR \times 2 \times \frac{CODE_{10} - 2048}{4096}$$

where  $CODE_{10}$  is the decimal equivalent of the digital output code as shown in Table 2. FSR is the full-scale range as shown in Figures 6 and 7.

Keep the capacitive load on the MAX1126 digital outputs as low as possible.

## LVDS and SLVS Signals (SLVS/LVDS)

Drive SLVS/LVDS low for LVDS or drive SLVS/LVDS high for scalable low-voltage signaling (SLVS) levels at the MAX1126 outputs (OUT\_P, OUT\_N, CLKOUTP, CLKOUTN, FRAMEP, and FRAMEN). For SLVS levels,

Table 2. Output Code Table ( $V_{REFIO} = 1.24V$ )

| TWO'S COMPLEMENT DIGITAL OUTPUT CODE<br>( $\overline{T}/B = 0$ ) |                                             |                                         | OFFSET BINARY DIGITAL OUTPUT CODE<br>( $\overline{T}/B = 1$ ) |                                             |                                         | $V_{IN\_P} - V_{IN\_N}$ (mV)<br>( $V_{REFIO} = 1.24V$ ) |
|------------------------------------------------------------------|---------------------------------------------|-----------------------------------------|---------------------------------------------------------------|---------------------------------------------|-----------------------------------------|---------------------------------------------------------|
| BINARY<br>D11 → D0                                               | HEXADECIMAL<br>EQUIVALENT<br>OF<br>D11 → D0 | DECIMAL<br>EQUIVALENT<br>OF<br>D11 → D0 | BINARY<br>D11 → D0                                            | HEXADECIMAL<br>EQUIVALENT<br>OF<br>D11 → D0 | DECIMAL<br>EQUIVALENT<br>OF<br>D11 → D0 |                                                         |
| 0111 1111 1111                                                   | 0x7FF                                       | +2047                                   | 1111 1111 1111                                                | 0xFFF                                       | +4095                                   | +699.66                                                 |
| 0111 1111 1110                                                   | 0x7FE                                       | +2046                                   | 1111 1111 1110                                                | 0xFFE                                       | +4094                                   | +699.32                                                 |
|                                                                  |                                             |                                         |                                                               |                                             |                                         |                                                         |
| 0000 0000 0001                                                   | 0x001                                       | +1                                      | 1000 0000 0001                                                | 0x801                                       | +2049                                   | +0.34                                                   |
| 0000 0000 0000                                                   | 0x000                                       | 0                                       | 1000 0000 0000                                                | 0x800                                       | +2048                                   | 0                                                       |
| 1111 1111 1111                                                   | 0xFFFF                                      | -1                                      | 0111 1111 1111                                                | 0x7FF                                       | +2047                                   | -0.34                                                   |
|                                                                  |                                             |                                         |                                                               |                                             |                                         |                                                         |
| 1000 0000 0001                                                   | 0x801                                       | -2047                                   | 0000 0000 0001                                                | 0x001                                       | +1                                      | -699.66                                                 |
| 1000 0000 0000                                                   | 0x800                                       | -2048                                   | 0000 0000 0000                                                | 0x000                                       | 0                                       | -700.00                                                 |

# Quad, 12-Bit, 40Mps, 1.8V ADC with Serial LVDS Outputs

MAX1126

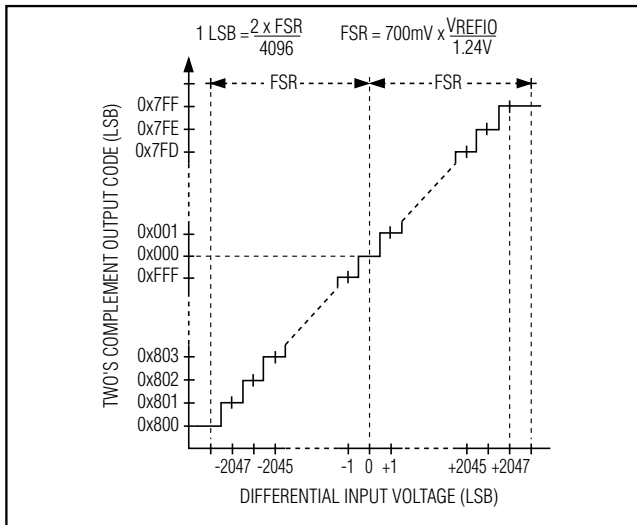


Figure 6. Bipolar Transfer Function with Two's Complement Output Code ( $\overline{T}/B = 0$ )

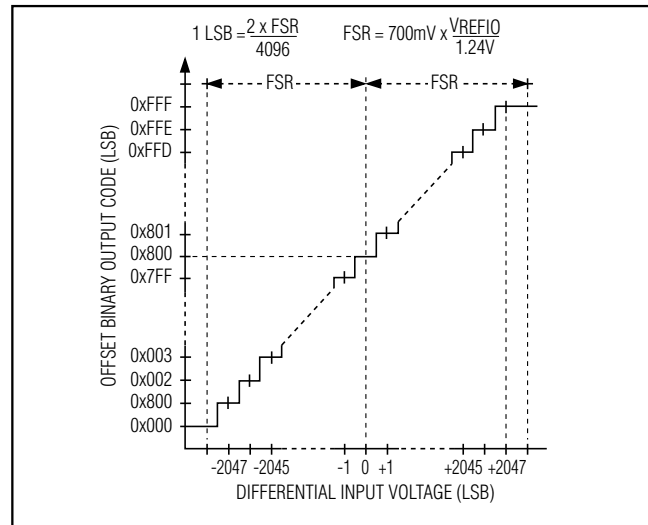


Figure 7. Bipolar Transfer Function with Offset Binary Output Code ( $\overline{T}/B = 1$ )

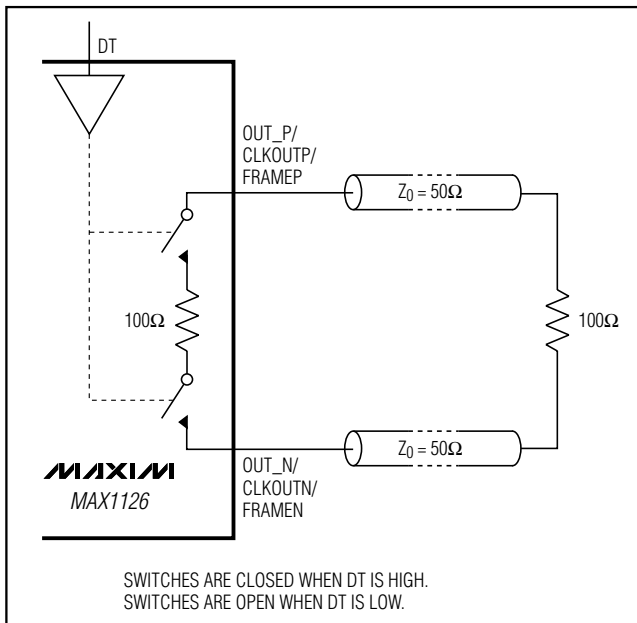


Figure 8. Double Termination

enable double termination by driving DT high. See the *Electrical Characteristics* table for LVDS and SLVS output voltage levels.

## LVDS Test Pattern (LVDSTEST)

Drive LVDSTEST high to enable the output test pattern on all LVDS or SLVS output channels. The output test pattern is 0000 1011 1101 MSB→LSB. As with the analog conversion results, the test pattern data is output

LSB first. Drive LVDSTEST low for normal operation (test pattern disabled).

## Common-Mode Output Voltage (CMOUT)

CMOUT provides a common-mode reference for DC-coupled analog inputs. If the input is DC-coupled, match the output common-mode voltage of the circuit driving the MAX1126 to the output voltage at CMOUT to within  $\pm 50\text{mV}$ . It is recommended that the output common-mode voltage of the driving circuit be derived from CMOUT.

## Double Termination (DT)

As shown in Figure 8, the MAX1126 offers an optional, internal  $100\Omega$  termination between the differential output pairs (OUT\_P and OUT\_N, CLKOUTP and CLKOUTN, FRAMEP and FRAMEN). In addition to the termination at the end of the line, a second termination directly at the outputs helps eliminate unwanted reflections down the line. This feature is useful in applications where trace lengths are long ( $> 5\text{in}$ ) or with mismatched impedance. Drive DT high to select double termination, or drive DT low to disconnect the internal termination resistor (single termination). Selecting double termination increases the  $\text{OV}_{\text{DD}}$  supply current (see the *Electrical Characteristics* table).

## Power-Down Modes

The MAX1126 offers two types of power-down inputs, PD0–PD3 and PDALL. The power-down modes allow the MAX1126 to efficiently use power by transitioning to a low-power state when conversions are not required.

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Independent Channel Power-Down (PD0–PD3)

PD0–PD3 control the power-down mode of each channel independently. Drive a power-down input high to power down its corresponding input channel. For example, to power down channel 1, drive PD1 high. Drive a power-down input low to place the corresponding input channel in normal operation. The differential output impedance of a powered-down output channel is approximately  $378\Omega$ , when DT is low. The output impedance of OUT\_P, with respect to OUT\_N, is  $100\Omega$  when DT is high. See the *Electrical Characteristics* table for typical supply currents with powered-down channels.

The state of the internal reference is independent of the PD0–PD3 inputs. To power down the internal reference circuitry, drive PDALL high (see the *Global Power-Down (PDALL)* section).

## Global Power-Down (PDALL)

PDALL controls the power-down mode of all channels and the internal reference circuitry. Drive PDALL high to enable global power-down. In global power-down mode, the output impedance of all the LVDS/SLVS outputs is approximately  $378\Omega$ , if DT is low. The output impedance of the differential LVDS/SLVS outputs is  $100\Omega$  when DT is high. See the *Electrical Characteristics* table for typical supply currents with global power-down. The following list shows the state of the analog inputs and digital outputs in global power-down mode:

- IN\_P, IN\_N analog inputs are disconnected from the internal input amplifier.
- REFIO has  $> 1M\Omega$  resistance to GND.
- OUT\_P, OUT\_N, CLKOUTP, CLKOUTN, FRAMEP, and FRAMEN have approximately  $378\Omega$  between the output pairs when DT is low. When DT is high, the differential output pairs have  $100\Omega$  between each pair.

When operating from the internal reference, the wake-up time from global power-down is typically  $132\mu s$ . When using an external reference, the wake-up time is dependent on the external reference drivers.

## Applications Information

### Full-Scale Range Adjustments Using the Internal Reference

The MAX1126 supports a full-scale adjustment range of 10% ( $\pm 5\%$ ). To decrease the full-scale range, add a  $25k\Omega$  to  $250k\Omega$  external resistor or potentiometer (RADJ) between REFADJ and GND. To increase the full-scale range, add a  $25k\Omega$  to  $250k\Omega$  resistor between REFADJ and REFIO. Figure 9 shows the two possible configurations.

The following equations provide the relationship between RADJ and the change in the analog full-scale range:

$$FSR = 0.7V \left( 1 + \frac{1.25k\Omega}{R_{ADJ}} \right)$$

for RADJ connected between REFADJ and REFIO, and

$$FSR = 0.7V \left( 1 - \frac{1.25k\Omega}{R_{ADJ}} \right)$$

for RADJ connected between REFADJ and GND.

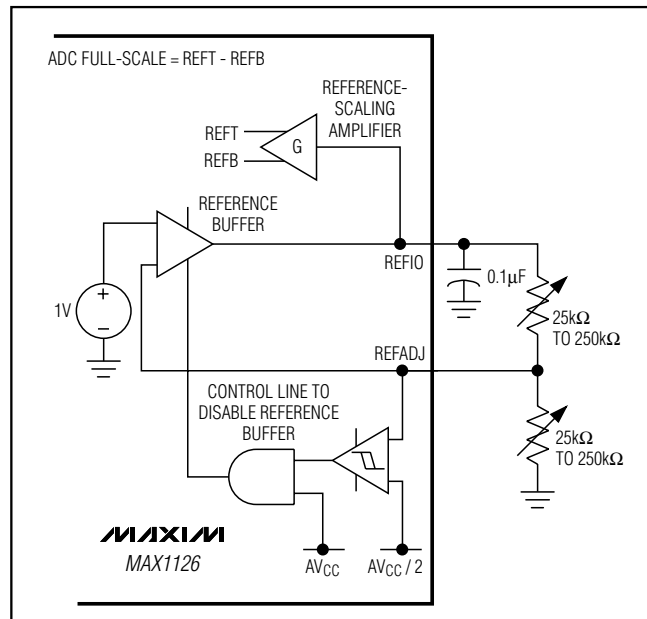


Figure 9. Circuit Suggestions to Adjust the ADC's Full-Scale Range

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

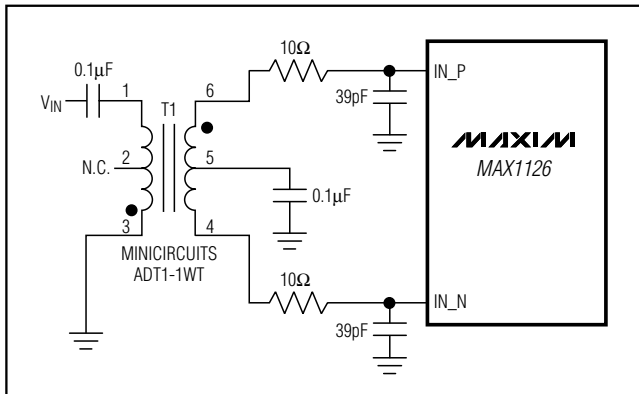


Figure 10. Transformer-Coupled Input Drive

## Using Transformer Coupling

An RF transformer (Figure 10) provides an excellent solution to convert a single-ended input source signal to a fully differential signal, required by the MAX1126 for optimum performance. The MAX1126 input common-mode voltage is internally biased to 0.76V (typ) with  $f_{CLK} = 40\text{MHz}$ . Although a 1:1 transformer is shown, a step-up transformer can be selected to reduce the drive requirements. A reduced signal swing from the input driver, such as an op amp, can also improve the overall distortion.

## Grounding, Bypassing, and Board Layout

The MAX1126 requires high-speed board layout design techniques. Refer to the MAX1127 EV kit data sheet for a board layout reference. Locate all bypass capacitors as close to the device as possible, preferably on the same side as the ADC, using surface-mount devices for minimum inductance. Bypass  $AV_{DD}$  to GND with a 0.1μF ceramic capacitor in parallel with a  $\geq 2.2\mu\text{F}$  ceramic capacitor. Bypass  $OV_{DD}$  to GND with a 0.1μF ceramic capacitor in parallel with a  $\geq 2.2\mu\text{F}$  ceramic capacitor. Bypass  $CV_{DD}$  to GND with a 0.1μF ceramic capacitor in parallel with a  $\geq 2.2\mu\text{F}$  ceramic capacitor.

Multilayer boards with ample ground and power planes produce the highest level of signal integrity. Connect MAX1126 ground pins and the exposed backside paddle to the same ground plane. The MAX1126 relies on the exposed backside paddle connection for a low-

inductance ground connection. Isolate the ground plane from any noisy digital system ground planes.

Route high-speed digital signal traces away from the sensitive analog traces. Keep all signal lines short and free of 90° turns.

Ensure that the differential analog input network layout is symmetric and that all parasitics are balanced equally. Refer to the MAX1126 EV kit data sheet for an example of symmetric input layout.

## Parameter Definitions

### Integral Nonlinearity (INL)

Integral nonlinearity is the deviation of the values on an actual transfer function from a straight line. For the MAX1126, this straight line is between the end points of the transfer function, once offset and gain errors have been nullified. INL deviations are measured at every step and the worst-case deviation is reported in the *Electrical Characteristics* table.

### Differential Nonlinearity (DNL)

Differential nonlinearity is the difference between an actual step width and the ideal value of 1 LSB. A DNL error specification of less than 1 LSB guarantees no missing codes and a monotonic transfer function. For the MAX1126, DNL deviations are measured at every step and the worst-case deviation is reported in the *Electrical Characteristics* table.

### Offset Error

Offset error is a figure of merit that indicates how well the actual transfer function matches the ideal transfer function at a single point. For the MAX1126, the ideal midscale digital output transition occurs when there is -1/2 LSB across the analog inputs (Figures 6 and 7). Bipolar offset error is the amount of deviation between the measured midscale transition point and the ideal midscale transition point.

### Gain Error

Gain error is a figure of merit that indicates how well the slope of the actual transfer function matches the slope of the ideal transfer function. For the MAX1126, the gain error is the difference of the measured full-scale and zero-scale transition points minus the difference of the ideal full-scale and zero-scale transition points.

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For the bipolar devices (MAX1126), the full-scale transition point is from 0x7FE to 0x7FF for two's complement output format (0xFFE to 0xFFF for offset binary) and the zero-scale transition point is from 0x800 to 0x801 for two's complement (0x000 to 0x001 for offset binary).

## Crosstalk

Crosstalk indicates how well each analog input is isolated from the others. For the MAX1126, a 5.3MHz, -0.5dBFS analog signal is applied to one channel while a 19.3MHz, -0.5dBFS analog signal is applied to all other channels. An FFT is taken on the channel with the 5.3MHz analog signal. From this FFT, the crosstalk is measured as the difference in the 5.3MHz and 19.3MHz amplitudes.

## Aperture Delay

Aperture delay ( $t_{AD}$ ) is the time defined between the rising edge of the sampling clock and the instant when an actual sample is taken. See Figure 10.

## Aperture Jitter

Aperture jitter ( $t_{AJ}$ ) is the sample-to-sample variation in the aperture delay. See Figure 11.

## Signal-to-Noise Ratio (SNR)

For a waveform perfectly reconstructed from digital samples, the theoretical maximum SNR is the ratio of the full-scale analog input (RMS value) to the RMS quantization error (residual error). The ideal, theoretical minimum analog-to-digital noise is caused by quantization error only and results directly from the ADC's resolution (N bits):

$$\text{SNR}_{\text{dB}[\text{max}]} = 6.02\text{dB} \times N + 1.76\text{dB}$$

In reality, there are other noise sources besides quantization noise: thermal noise, reference noise, clock jitter, etc.

For the MAX1126, SNR is computed by taking the ratio of the RMS signal to the RMS noise. RMS noise includes all spectral components to the Nyquist frequency excluding the fundamental, the first six harmonics (HD2–HD7), and the DC offset.

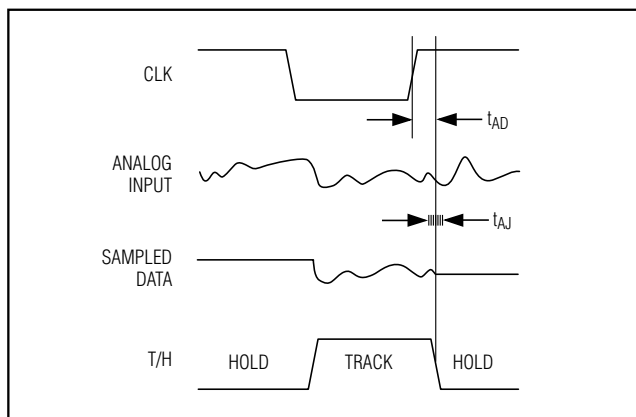


Figure 11. Aperture Jitter/Delay Specifications

## Signal-to-Noise Plus Distortion (SINAD)

SINAD is computed by taking the ratio of the RMS signal to the RMS noise plus distortion. RMS noise plus distortion includes all spectral components to the Nyquist frequency, excluding the fundamental and the DC offset.

## Effective Number of Bits (ENOB)

ENOB specifies the dynamic performance of an ADC at a specific input frequency and sampling rate. An ideal ADC's error consists of quantization noise only. ENOB for a full-scale sinusoidal input waveform is computed from:

$$\text{ENOB} = \left( \frac{\text{SINAD} - 1.76}{6.02} \right)$$

## Total Harmonic Distortion (THD)

THD is the ratio of the RMS sum of the first six harmonics of the input signal to the fundamental itself. This is expressed as:

$$\text{THD} = 20 \times \log \left( \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2 + V_7^2}}{V_1} \right)$$

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## Spurious-Free Dynamic Range (SFDR)

SFDR is the ratio expressed in decibels of the RMS amplitude of the fundamental (maximum signal component) to the RMS value of the next-largest spurious component, excluding DC offset. SFDR is specified in decibels relative to the carrier (dBc).

## Intermodulation Distortion (IMD)

IMD is the total power of the IM2 to IM5 intermodulation products to the Nyquist frequency relative to the total input power of the two input tones,  $f_1$  and  $f_2$ . The individual input tone levels are at -6.5dBFS. The intermodulation products are as follows:

- 2nd-order intermodulation products (IM2):  $f_1 + f_2$ ,  $f_2 - f_1$
- 3rd-order intermodulation products (IM3):  $2 \times f_1 - f_2$ ,  $2 \times f_2 - f_1$ ,  $2 \times f_1 + f_2$ ,  $2 \times f_2 + f_1$
- 4th-order intermodulation products (IM4):  $3 \times f_1 - f_2$ ,  $3 \times f_2 - f_1$ ,  $3 \times f_1 + f_2$ ,  $3 \times f_2 + f_1$
- 5th-order intermodulation products (IM5):  $3 \times f_1 - 2 \times f_2$ ,  $3 \times f_2 - 2 \times f_1$ ,  $3 \times f_1 + 2 \times f_2$ ,  $3 \times f_2 + 2 \times f_1$

## Third-Order Intermodulation (IM3)

IM3 is the total power of the 3rd-order intermodulation product to the Nyquist frequency relative to the total input power of the two input tones  $f_1$  and  $f_2$ . The individual input tone levels are at -6.5dBFS. The 3rd-order intermodulation products are  $2 \times f_1 - f_2$ ,  $2 \times f_2 - f_1$ ,  $2 \times f_1 + f_2$ ,  $2 \times f_2 + f_1$ .

## Small-Signal Bandwidth

A small -20dBFS analog input signal is applied to an ADC so the signal's slew rate does not limit the ADC's performance. The input frequency is then swept up to the point where the amplitude of the digitized conversion result has decreased by 3dB.

## Full-Power Bandwidth

A large -0.5dBFS analog input signal is applied to an ADC, and the input frequency is swept up to the point where the amplitude of the digitized conversion result has decreased by 3dB. This point is defined as full-power input bandwidth frequency.

## Gain Matching

Gain matching is a figure of merit that indicates how well the gain of all four ADC channels is matched to each other. For the MAX1126, gain matching is measured by applying the same 19.3MHz, -0.5dBFS analog signal to all analog input channels. These analog inputs are sampled at 40MHz and the maximum deviation in amplitude is reported in dB as gain matching in the *Electrical Characteristics* table.

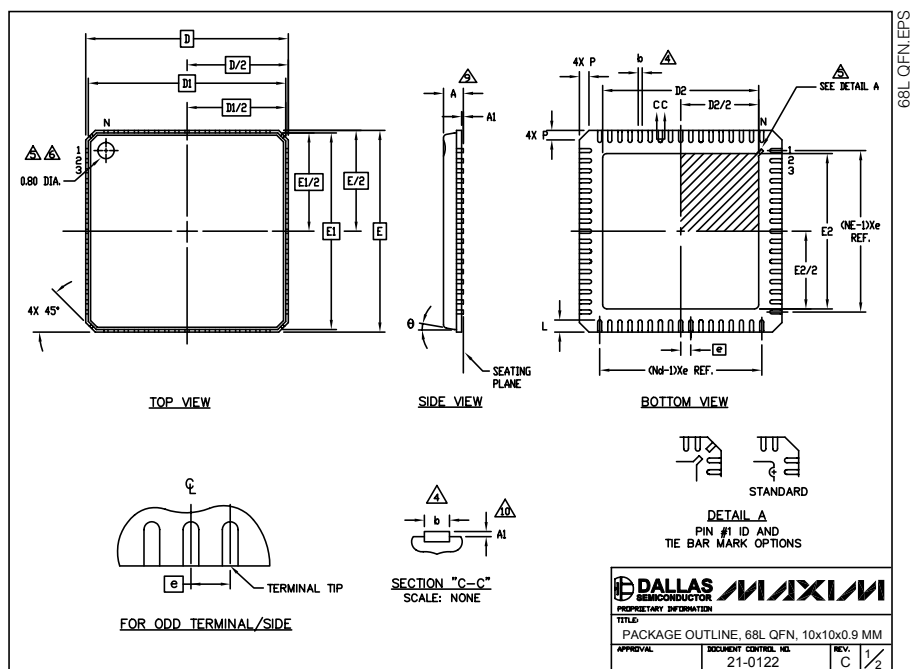
## Phase Matching

Phase matching is a figure of merit that indicates how well the phase of all four ADC channels is matched to each other. For the MAX1126, phase matching is measured by applying the same 19.3MHz, -0.5dBFS analog signal to all analog input channels. These analog inputs are sampled at 40MHz and the maximum deviation in phase is reported in degrees as phase matching in the *Electrical Characteristics* table.

# Quad, 12-Bit, 40Msps, 1.8V ADC with Serial LVDS Outputs

## Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)



| SYMBOL | COMMON DIMENSIONS |           |      | N <sub>T</sub> | N <sub>e</sub> |
|--------|-------------------|-----------|------|----------------|----------------|
|        | MIN.              | NOM.      | MAX. |                |                |
| A      | —                 | 0.90      | 1.00 |                |                |
| A1     | 0.00              | 0.01      | 0.05 | 11             |                |
| b      | 0.18              | 0.23      | 0.30 | 4              |                |
| D      |                   | 10.00 BSC |      |                |                |
| D1     |                   | 9.75 BSC  |      |                |                |
| ⓪      |                   | 0.50 BSC  |      |                |                |
| E      |                   | 10.00 BSC |      |                |                |
| E1     |                   | 9.75 BSC  |      |                |                |
| L      | 0.50              | 0.60      | 0.65 |                |                |
| N      |                   | 68        |      | 3              |                |
| Nd     |                   | 17        |      | 3              |                |
| Ne     |                   | 17        |      | 3              |                |
| ⓪      | 0                 |           | 12°  |                |                |
| P      | 0                 | 0.42      | 0.60 |                |                |

| EXPOSED PAD VARIATIONS |      |      |      |      |      |      |
|------------------------|------|------|------|------|------|------|
| PKG CODE               | D2   |      |      | E2   |      |      |
|                        | MIN  | NOM  | MAX  | MIN  | NOM  | MAX  |
| G6800-2                | 7.55 | 7.70 | 7.85 | 7.55 | 7.70 | 7.85 |
| G6800-4                | 5.65 | 5.80 | 5.95 | 5.65 | 5.80 | 5.95 |

**Note:** For the MAX1126 Exposed Pad Variation, the package code is G6800-4.

**DALLAS MAXIM SEMICONDUCTOR**

**PROPRIETARY INFORMATION**

**TITLE:** PACKAGE OUTLINE, 68LQFN, 10x10x0.9 MM

**APPROVAL:** DOCUMENT CONTROL, 21-0122

**REV. C 1/2**

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